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## CAD Note:

Default component footprint is SMD 0201, X5R, 1% resistors.

Property: BUILD-OPT

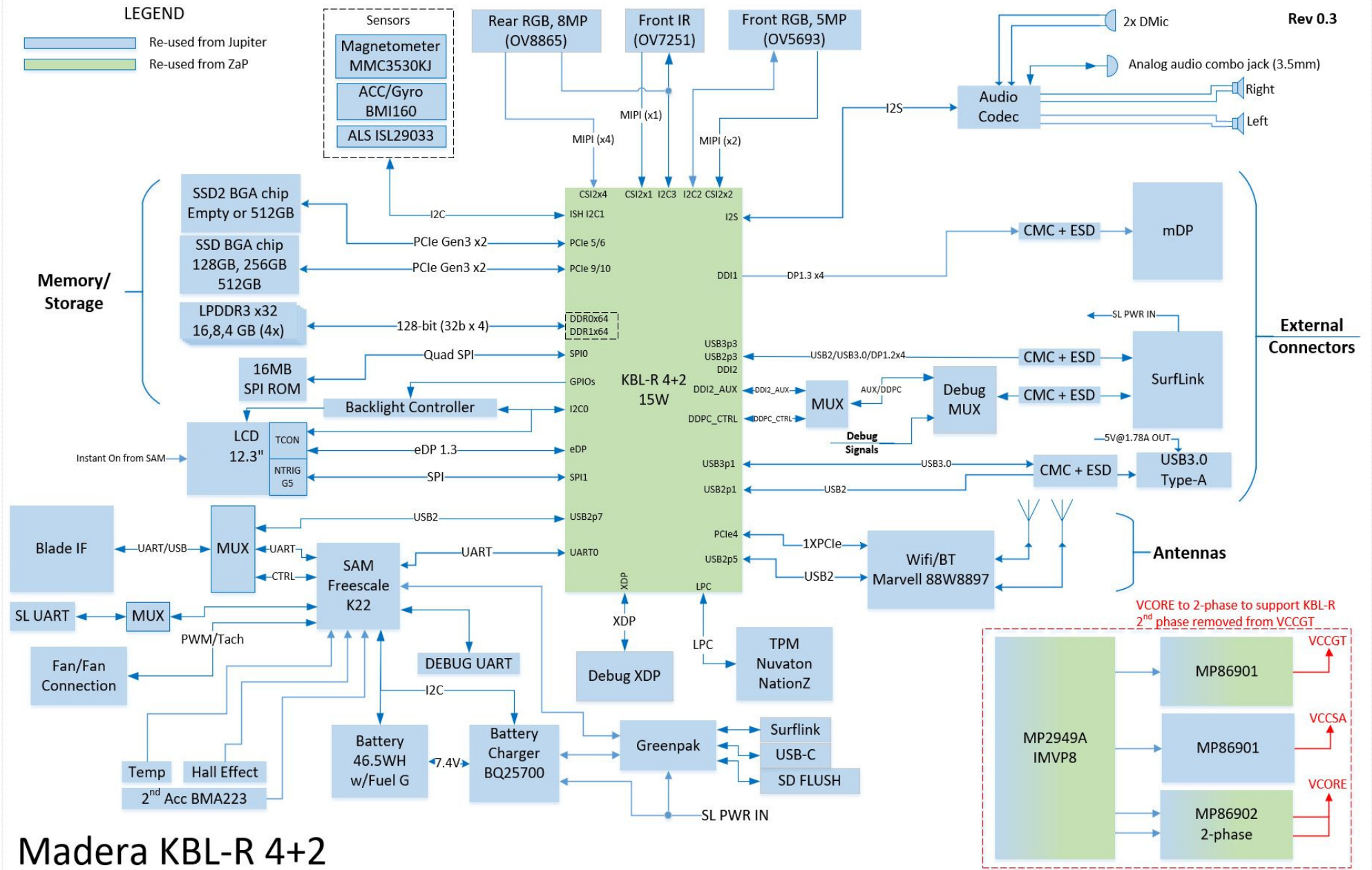
DNP = Do Not Place

S or DB = Replace after Debug

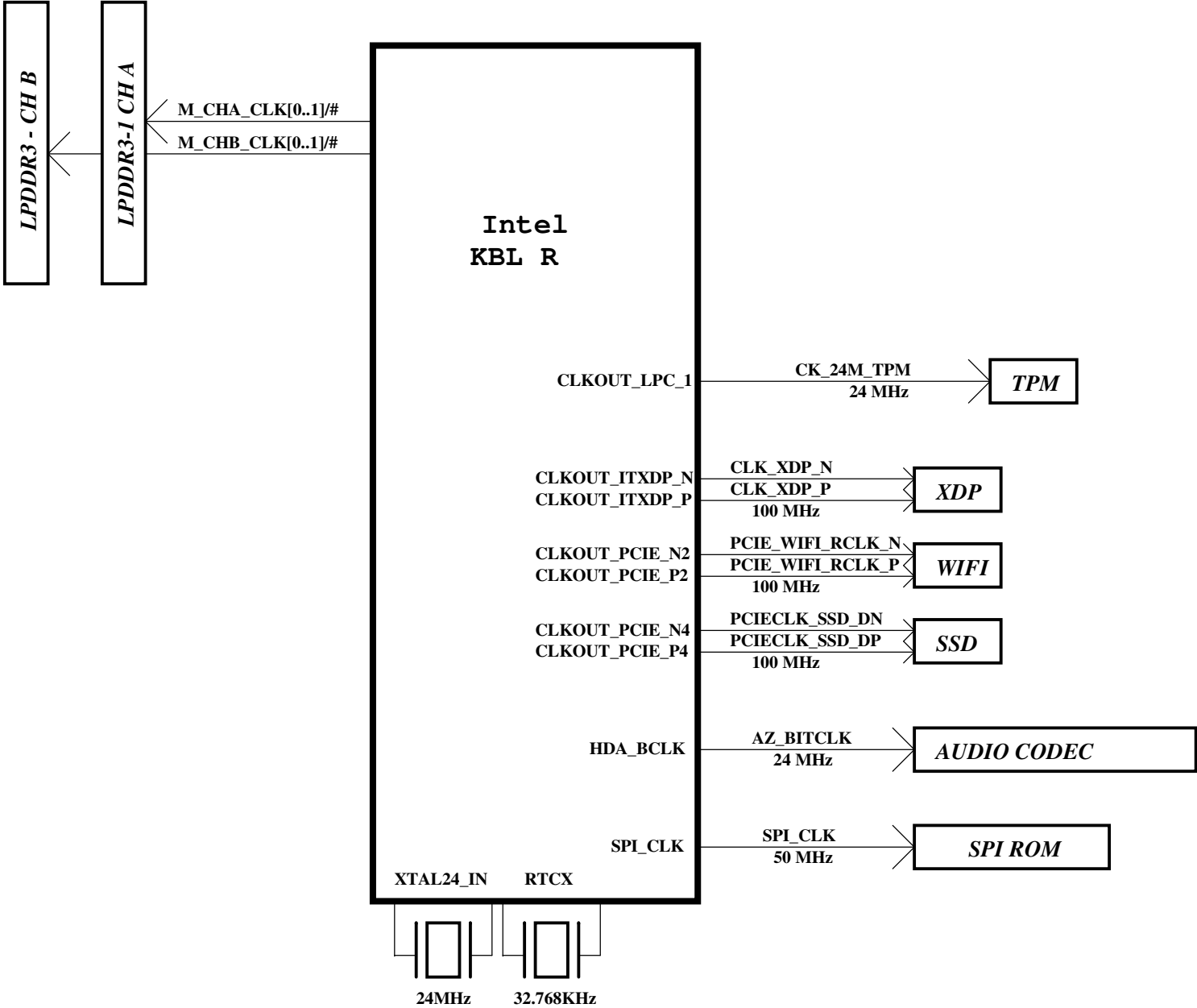
BUILD-OPT	BOM Assy	Remarks
ALL	Common	DEFAULT - Populated as shown in Core schematic for all variants
DNP	Common	NO-STUFF for all variants
TBL1001	CPU	CPU selection
TBL3602	CPU	Res Jumpers
<b>TBL5001</b>	<b>CPU</b>	<b>SOC dependant WiFi tuning options</b>
TBL2301	Bd ID	Res Jumpers
TBL3601	BdID	Res Jumpers
TBL1601	Mem	LPDDR3 Memory Assembly Options
TBL3801	TPM	Security Device Options
TBL4301	SSD	SSD Memory part options
SSD1	SSD	Only populated for single SSD configurations.
SSD2	SSD	Only populated for dual SSD configurations.
<i>DBG_D_TBL4301</i>	<i>SSD</i>	<i>Debug Part - Remove from SSD Assy for MP, Install for SSD Debug per TBL4301</i>
<i>DBG_R_SSD2</i>	<i>SSD</i>	<i>Debug Part - Replace with 0 ohm part for MP for dual SSD cfgs only.</i>
<i>DBG_S_SSD2</i>	<i>SSD</i>	<i>Debug Part - Remove from SSD Assy for MP for dual SSD cfg. Replaced w/ Board Short.</i>
S	Debug	Legacy - Originally intended same as DBG_S. please replace with DBG_S, DBG_R, or DBG_D as appropriate.
<i>DBG</i>	<i>Debug</i>	<i>Legacy - Same as DBG_D shown below. Part depopulated for MP.</i>
DBG_D	Debug	Debug Part - Remove from BOM (Depopulate) for MP
DBG_N	Debug	Non-Debug Part - Installed only in non-debug builds
DBG_R	Debug	Debug Part - Replace with lower cost component for MP (Ex; replace precision shunt with 0-ohm jumper)
DBG_S	Debug	Debug Part - Replace with board short for MP (not commonly used anymore)
DBG_T	Debug	Debug Part - Used for Power Telemetry in MP as needed.
XDP	XDP	Legacy - Same as XDP_D
XDP_D	XDP	Only used as needed for CPU Debug. Depopulated for MP and most EV/DV/PV assemblies.
FAN	FAN	Parts used to support Fan option.
<i>DBG_R_FAN</i>	<i>FAN</i>	<i>Debug Part - Replace part in Fan Assy with 0 ohm jumper for MP cfgs using FAN.</i>

## CAD Note:

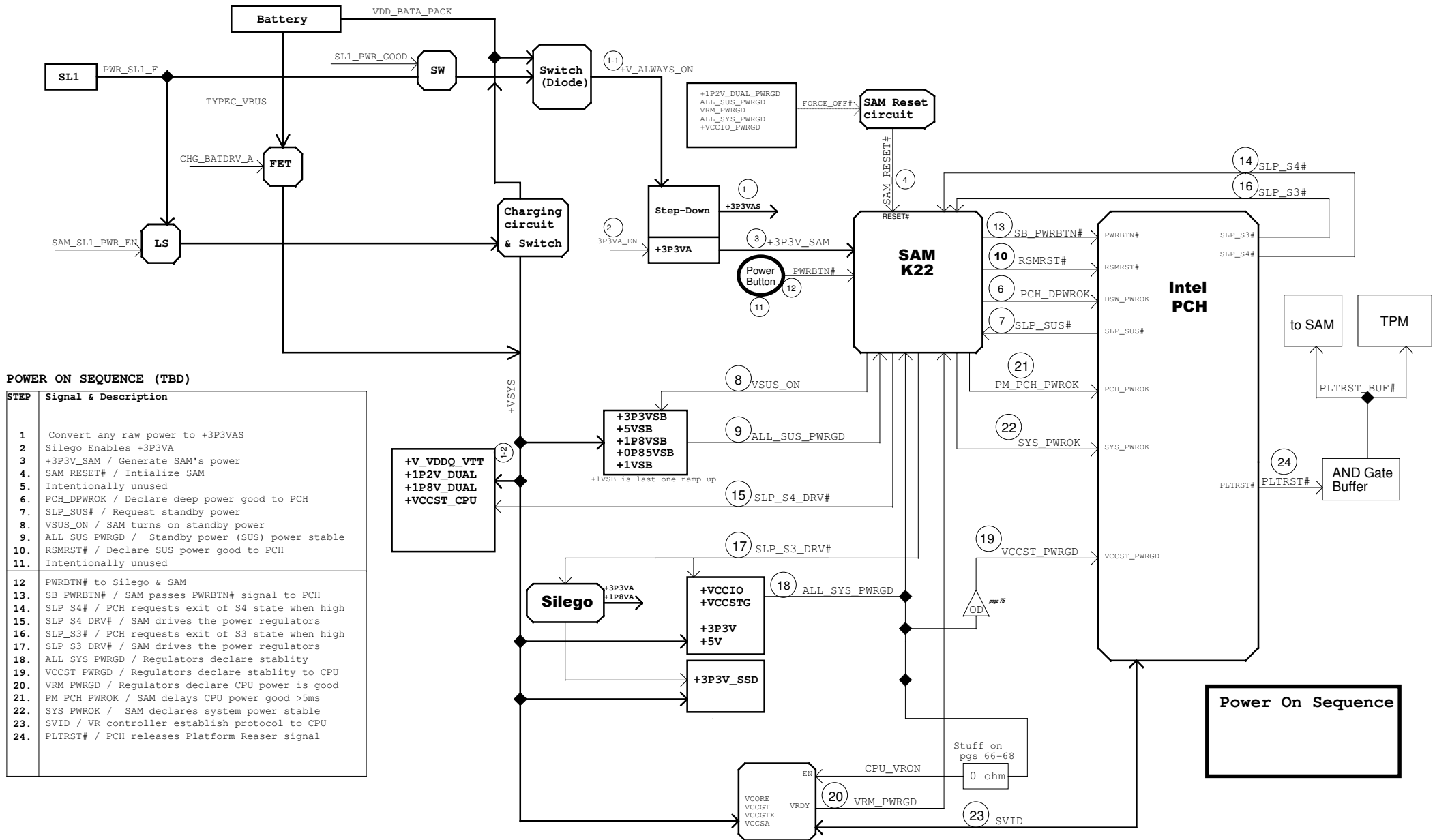
Defaults: Footprint SMD 0201, Cap tmp Coeff X5R, 1% resistors

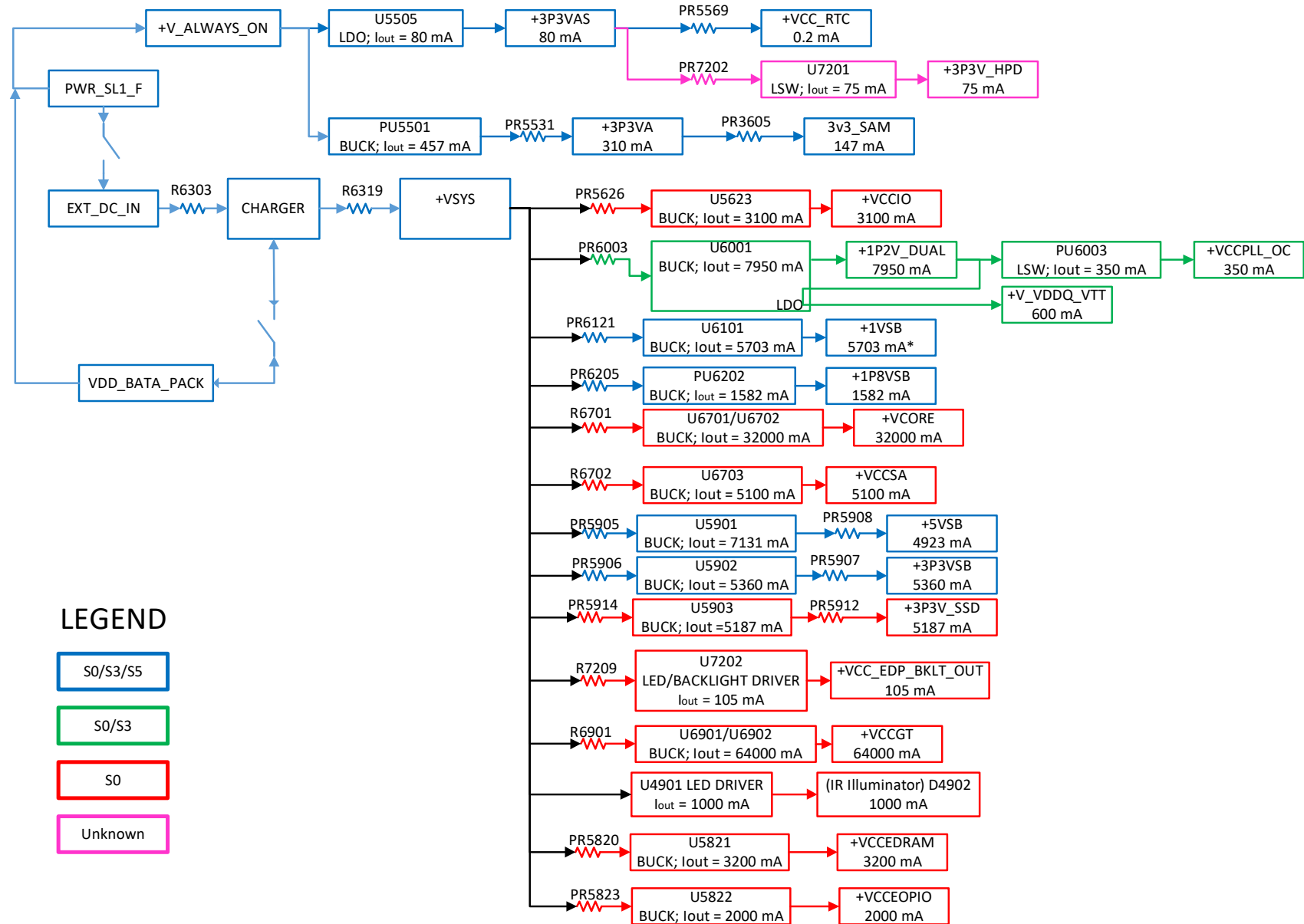


Madera KBL-R 4+2



# SIGNAL & RESET MAP

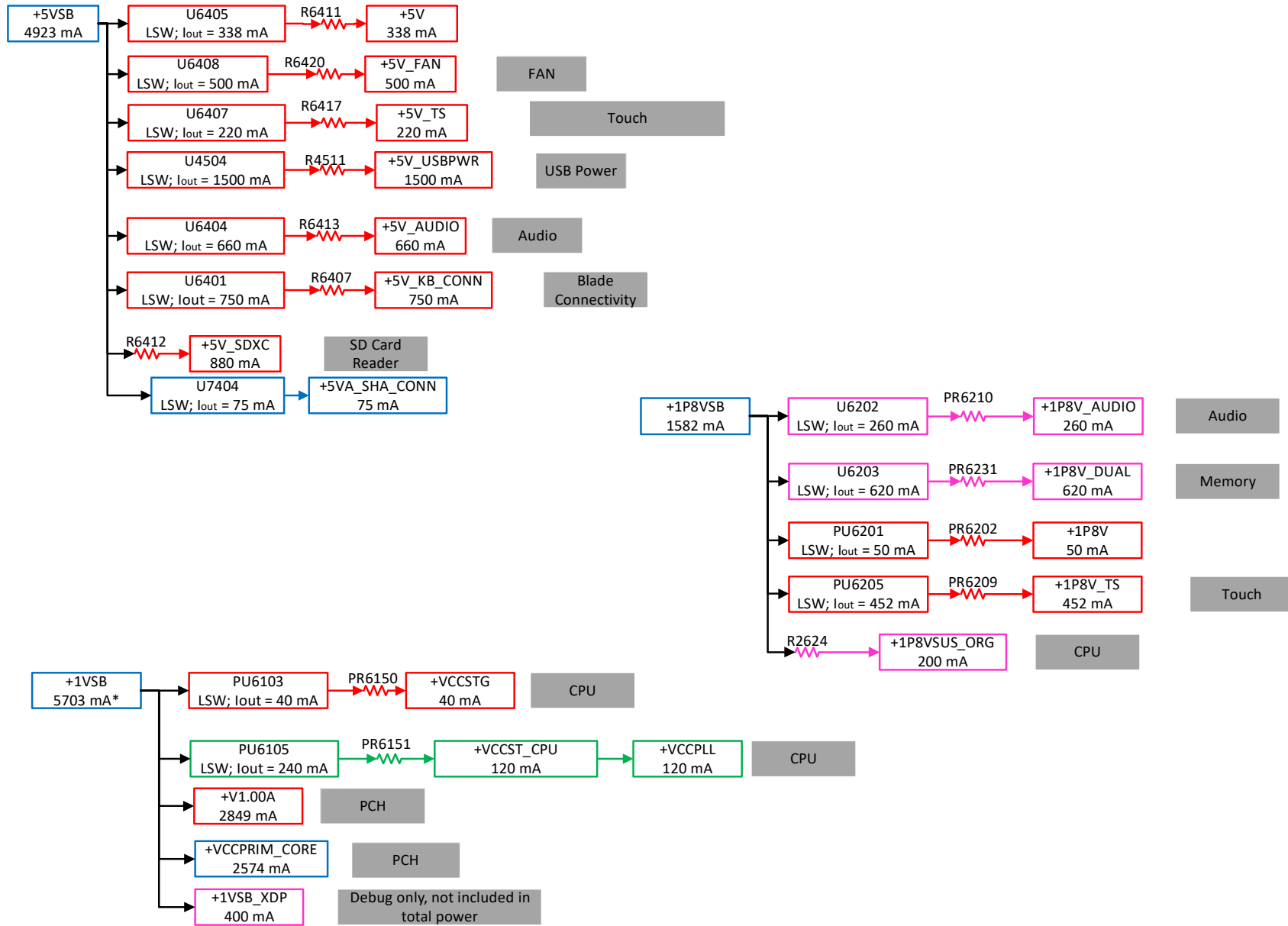


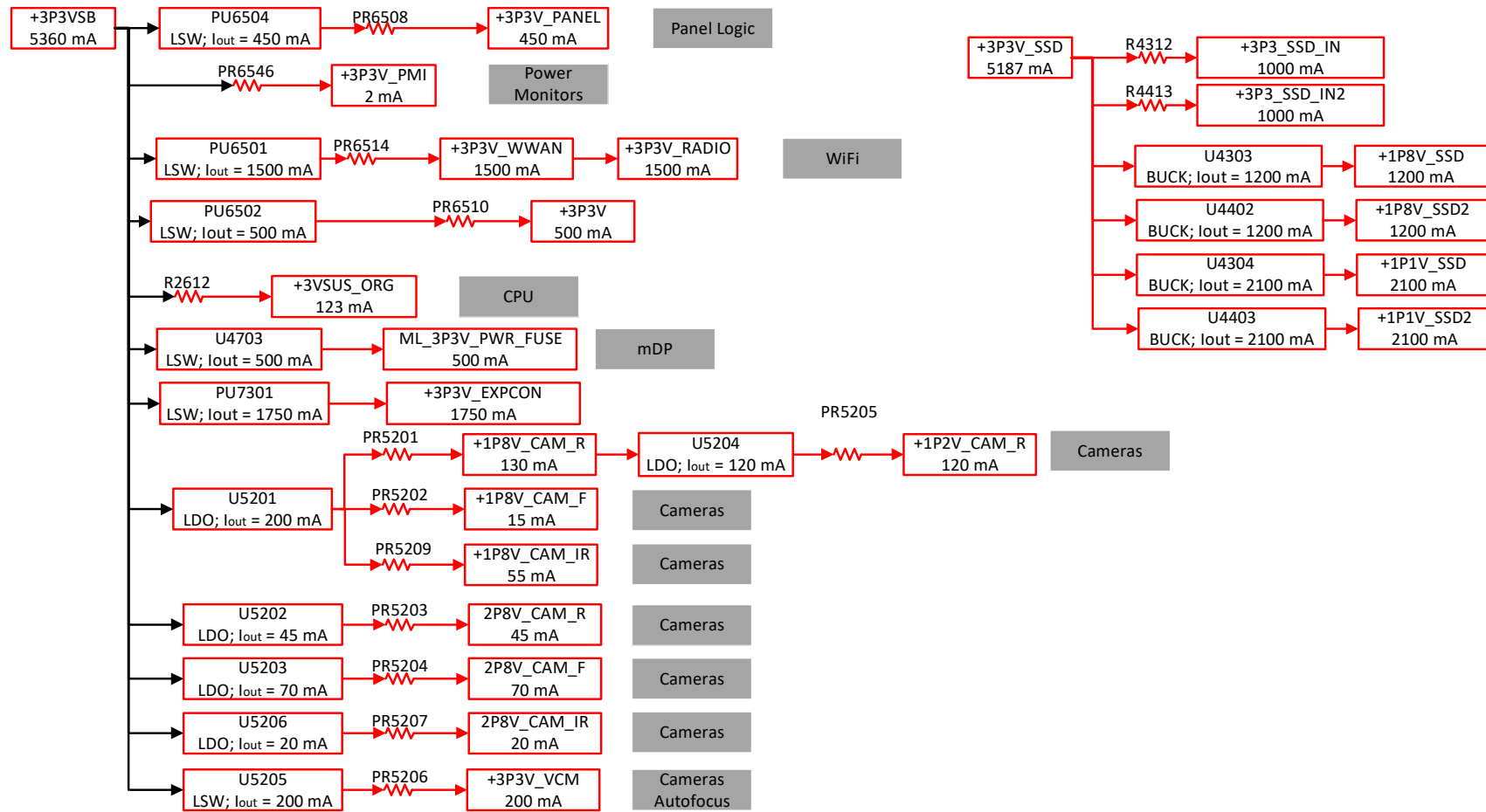


## LEGEND

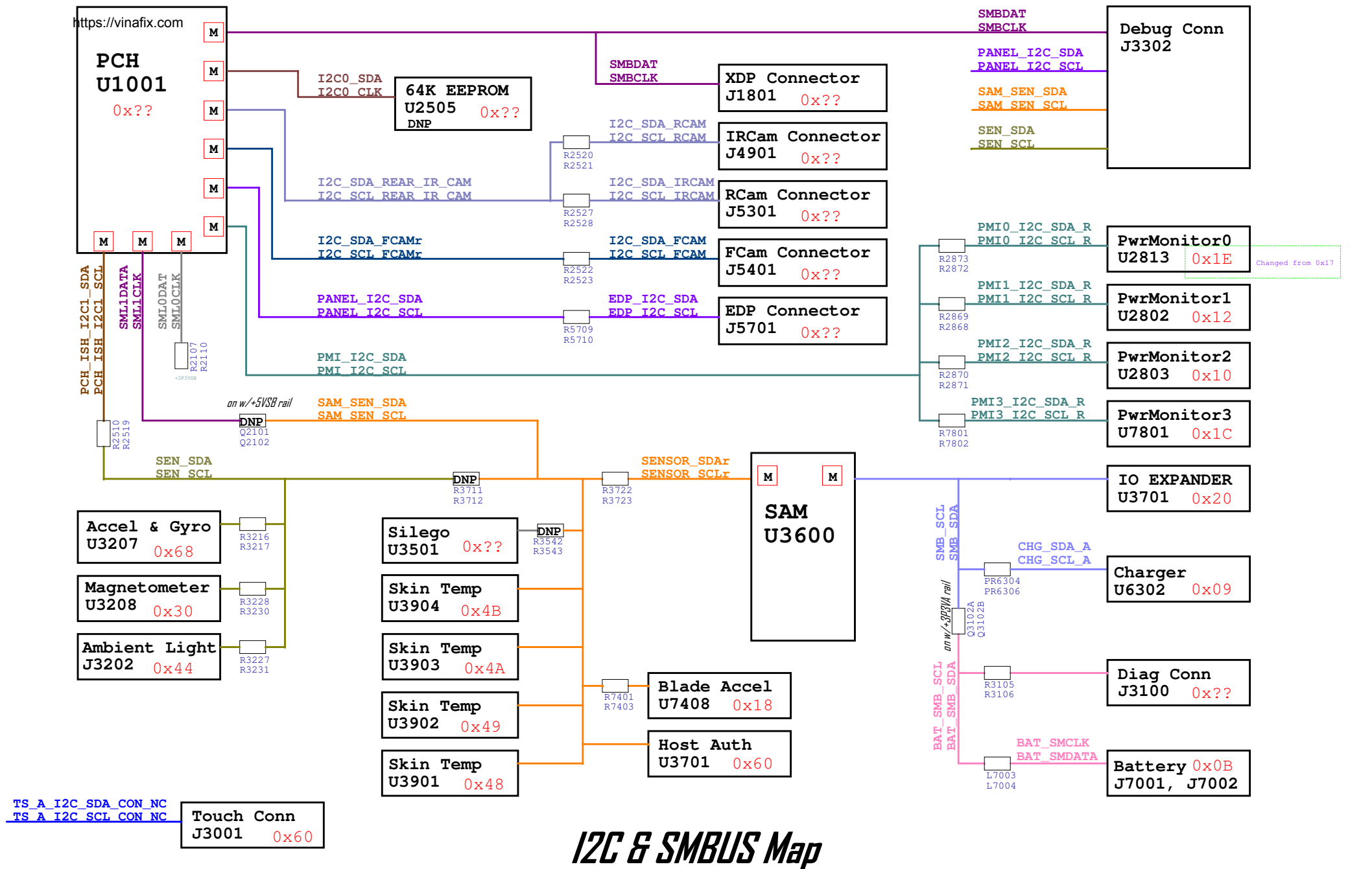
S0/S3/S5
S0/S3
S0
Unknown

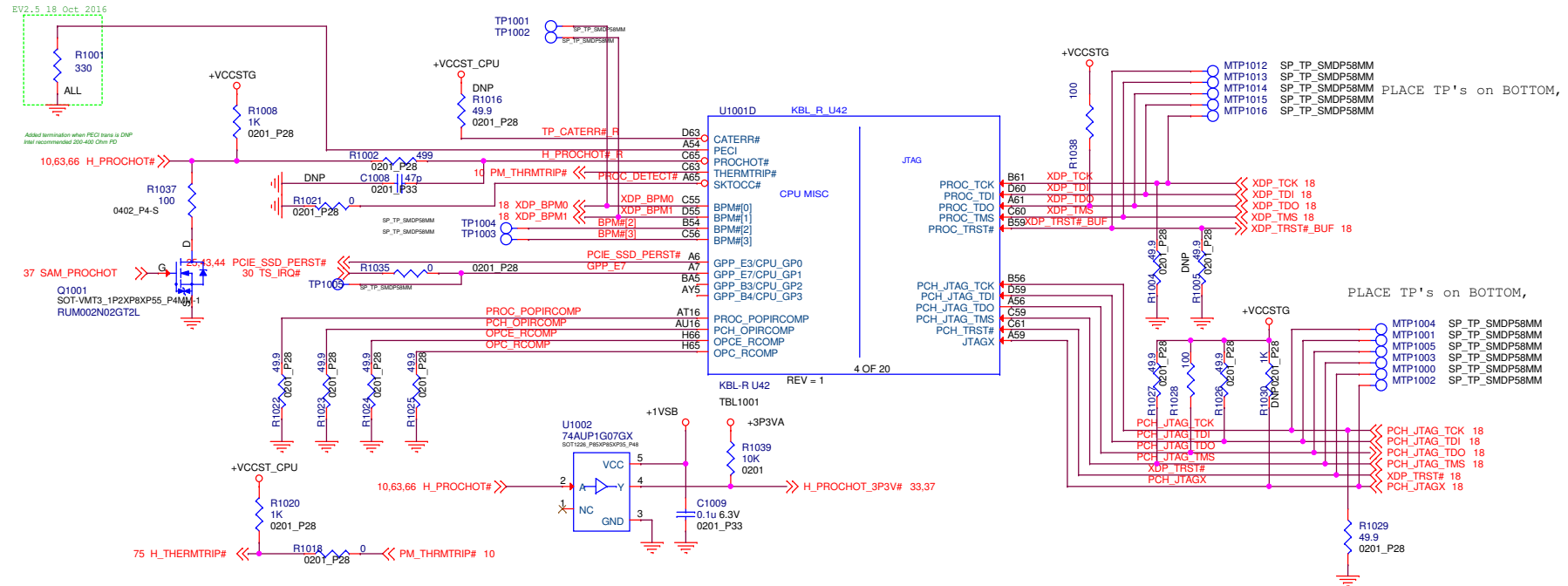
<https://vinafix.com>

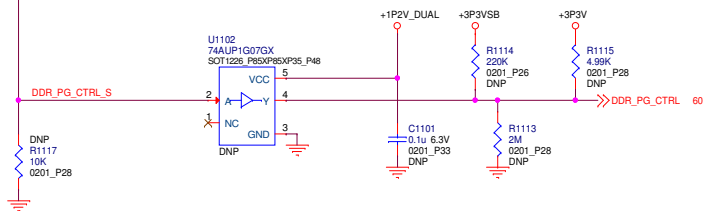
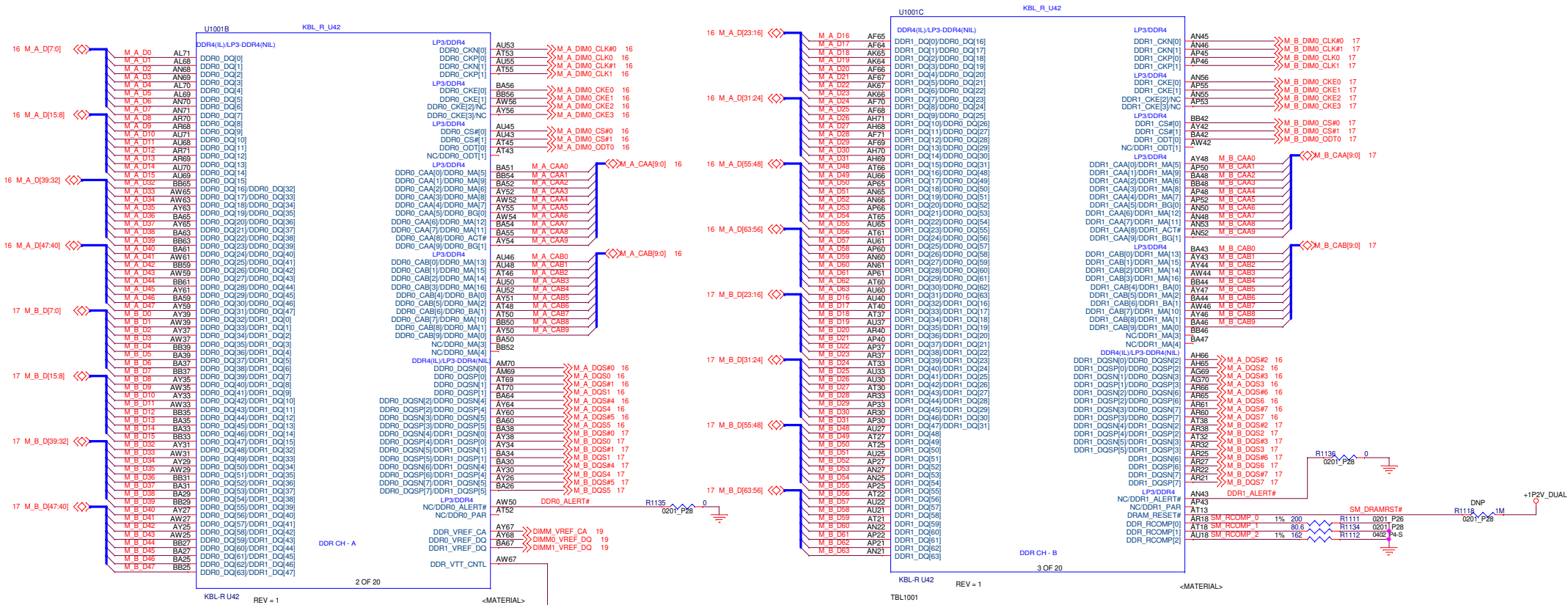




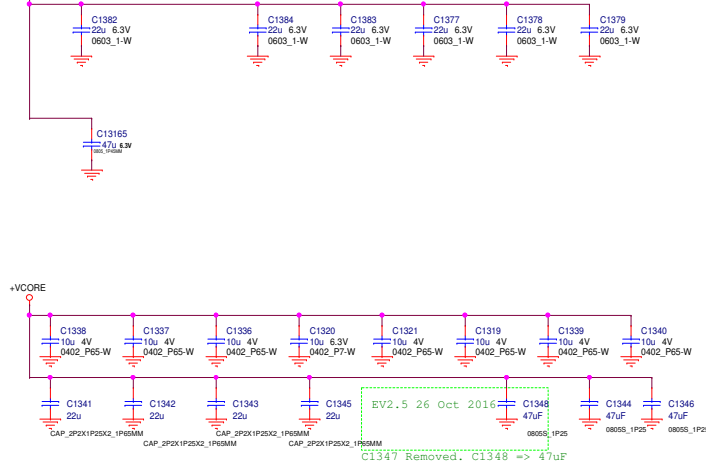
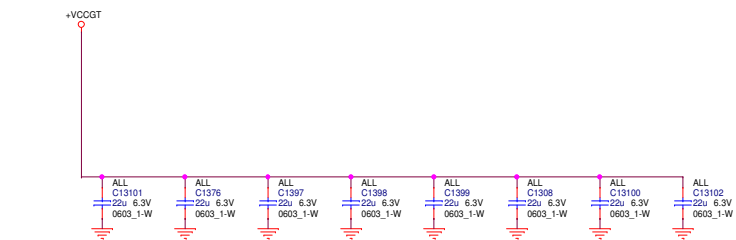


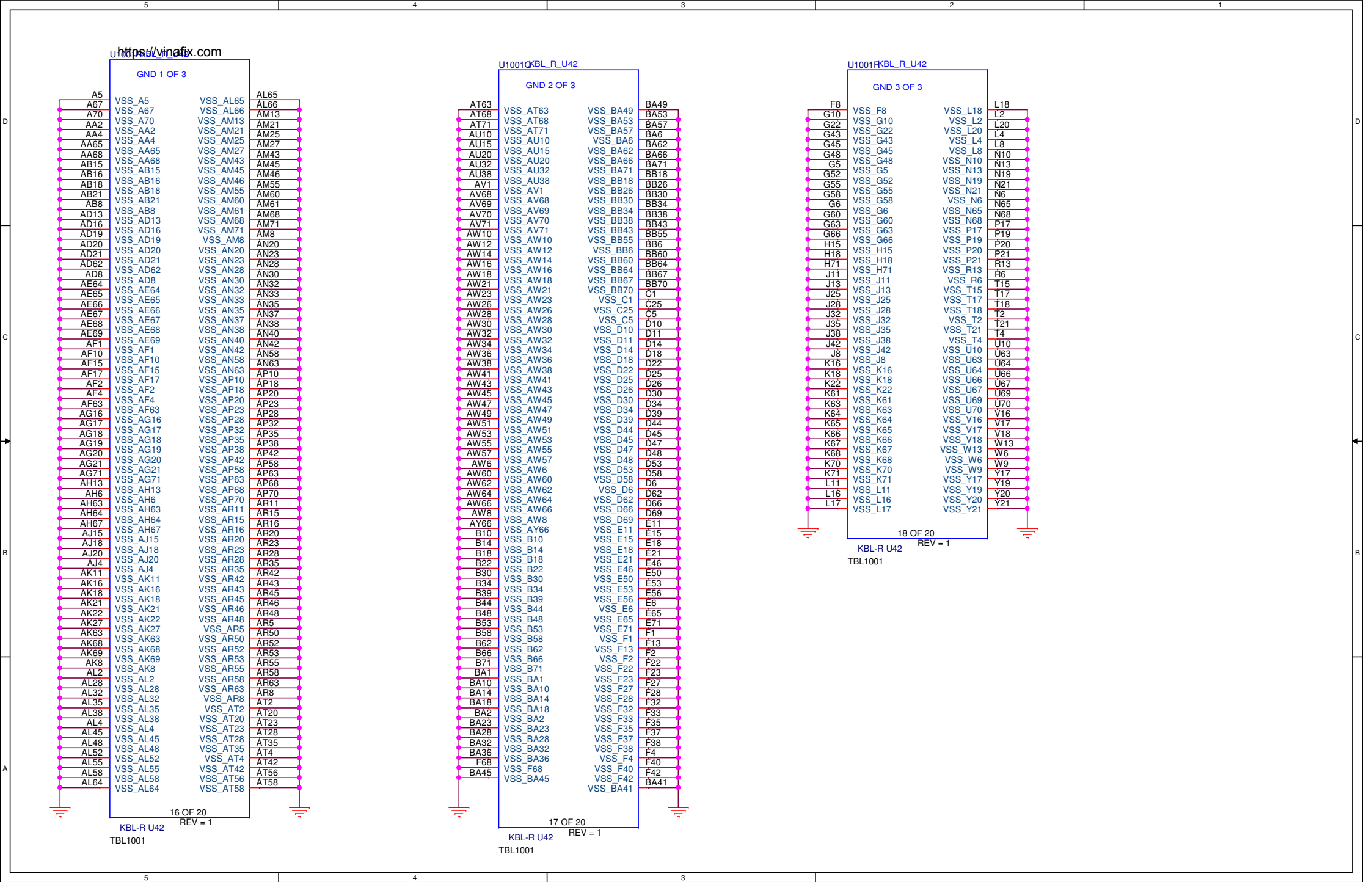






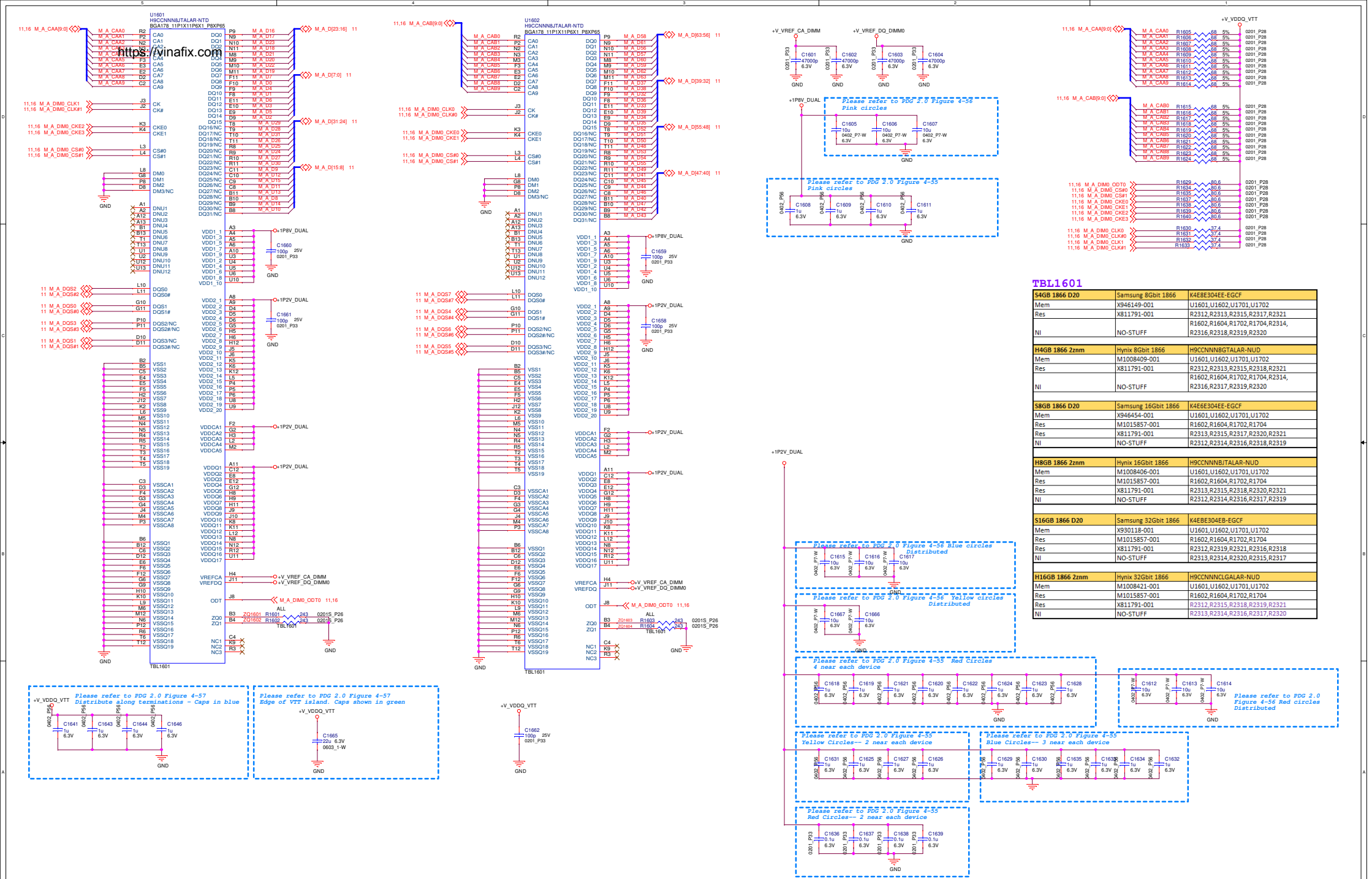




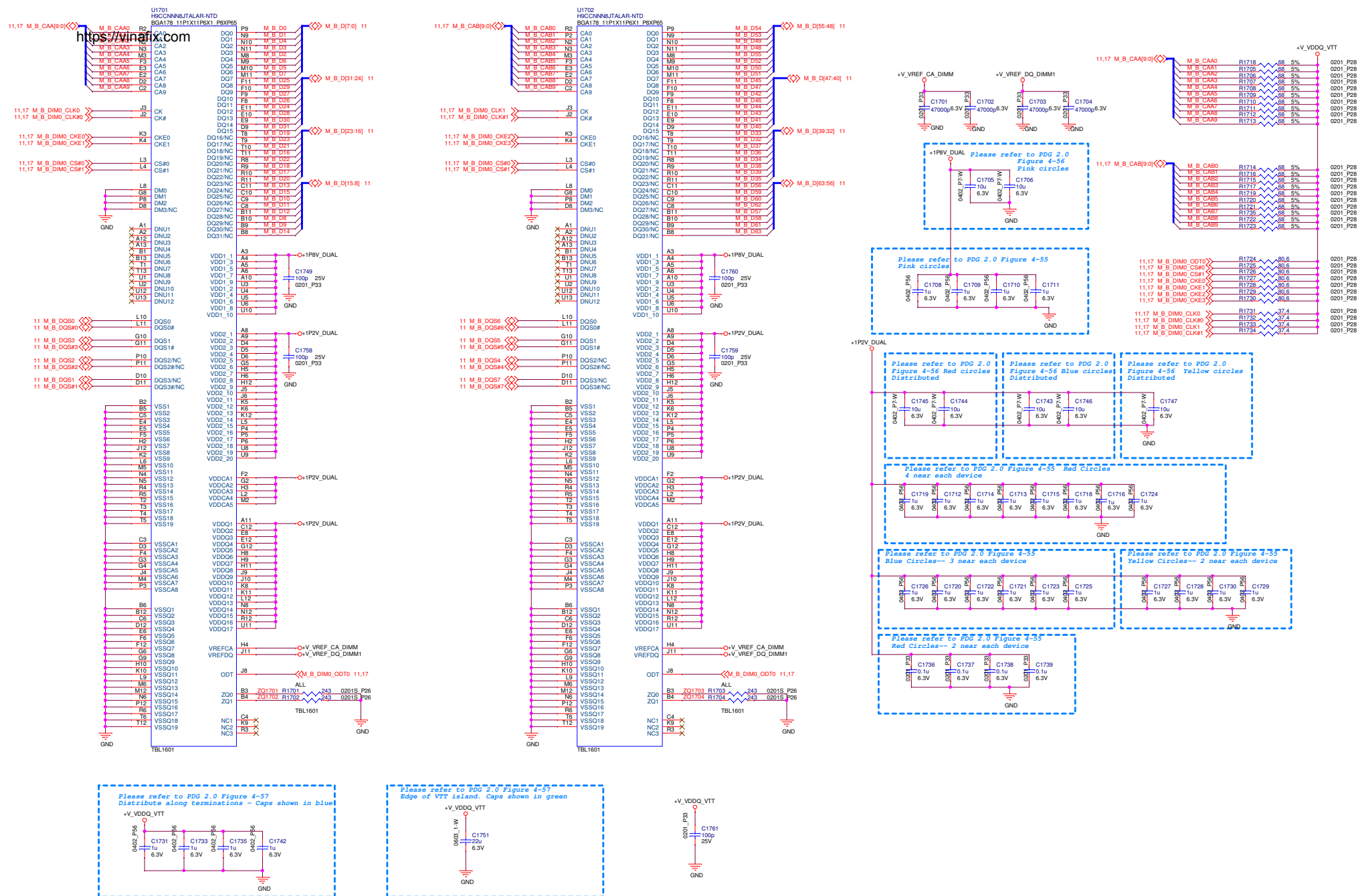


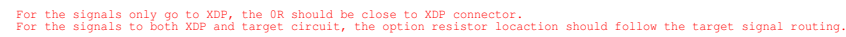








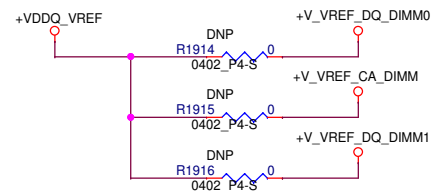
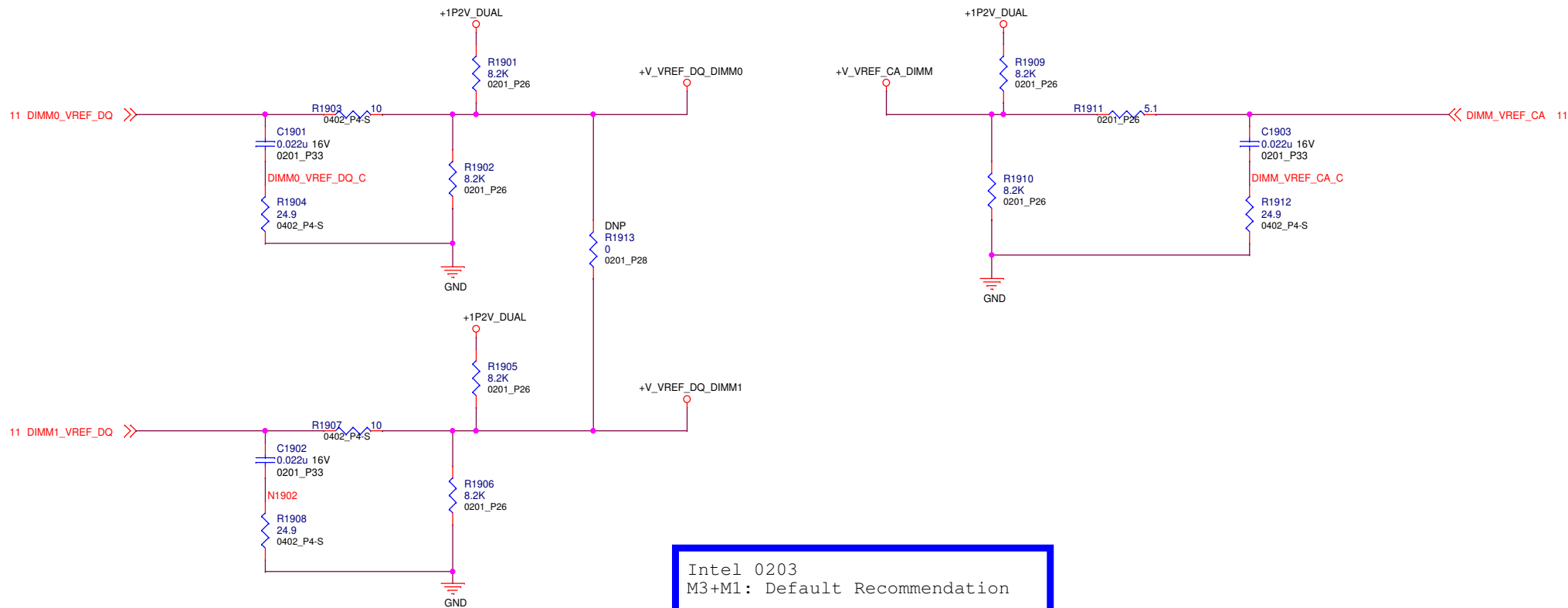




W x H 392 x 254 mm

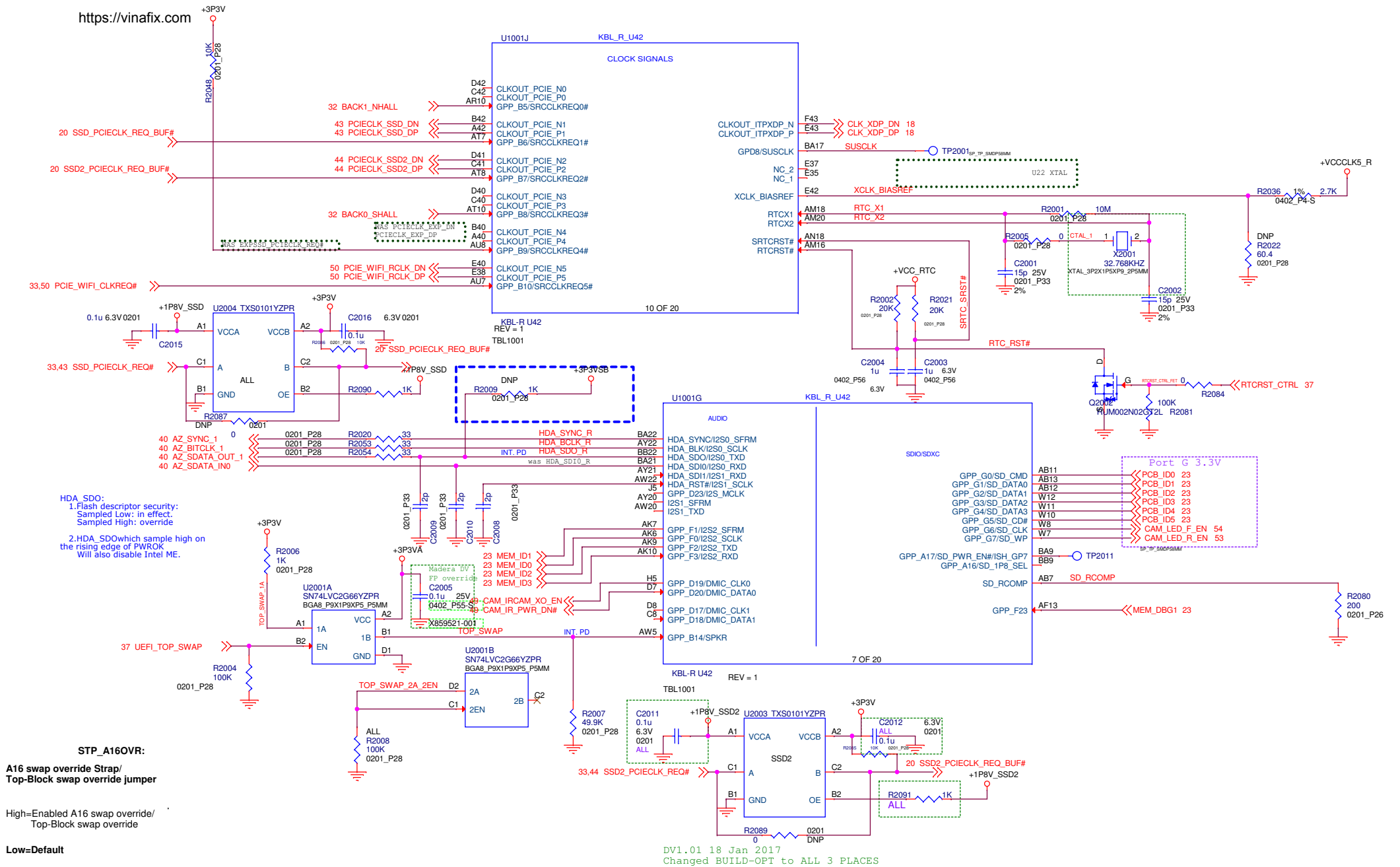
# LPDDR3 Vref

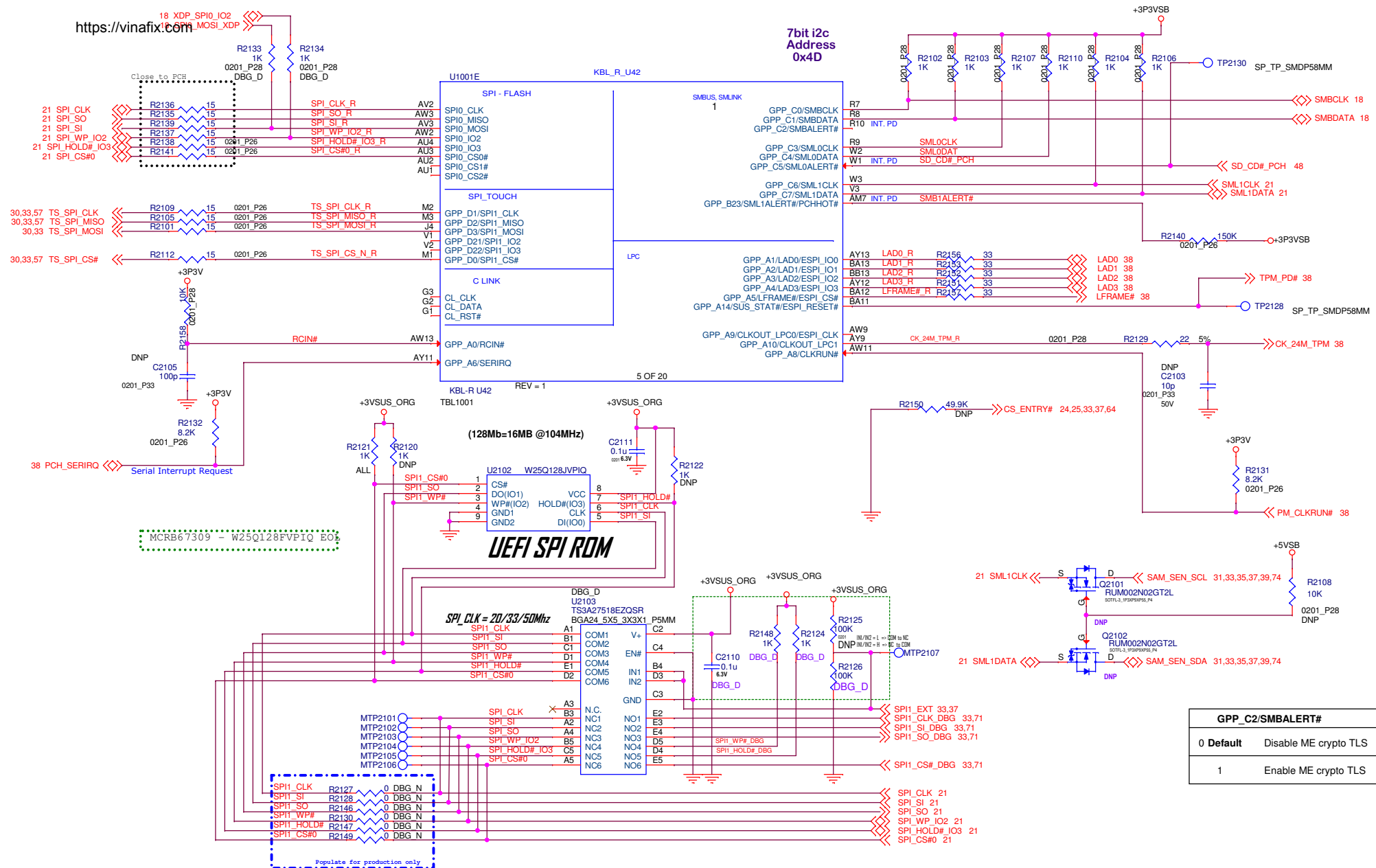
M3: CPU driven VREF path is stuffed be default.  
M1: VREF\_DQ driven by a Voltage Divider Network during Processor power-off

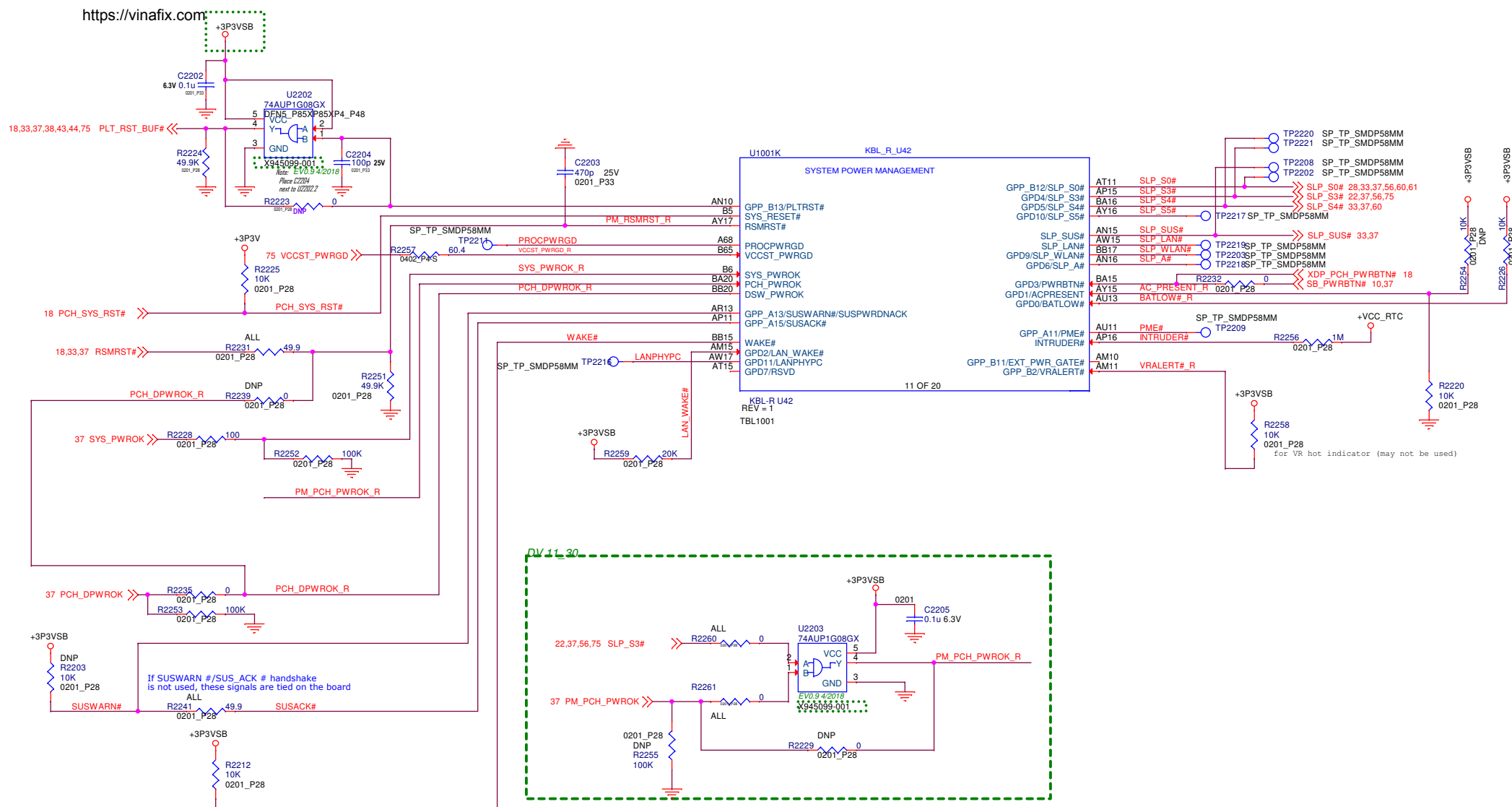


W x H 372 x 241 mm

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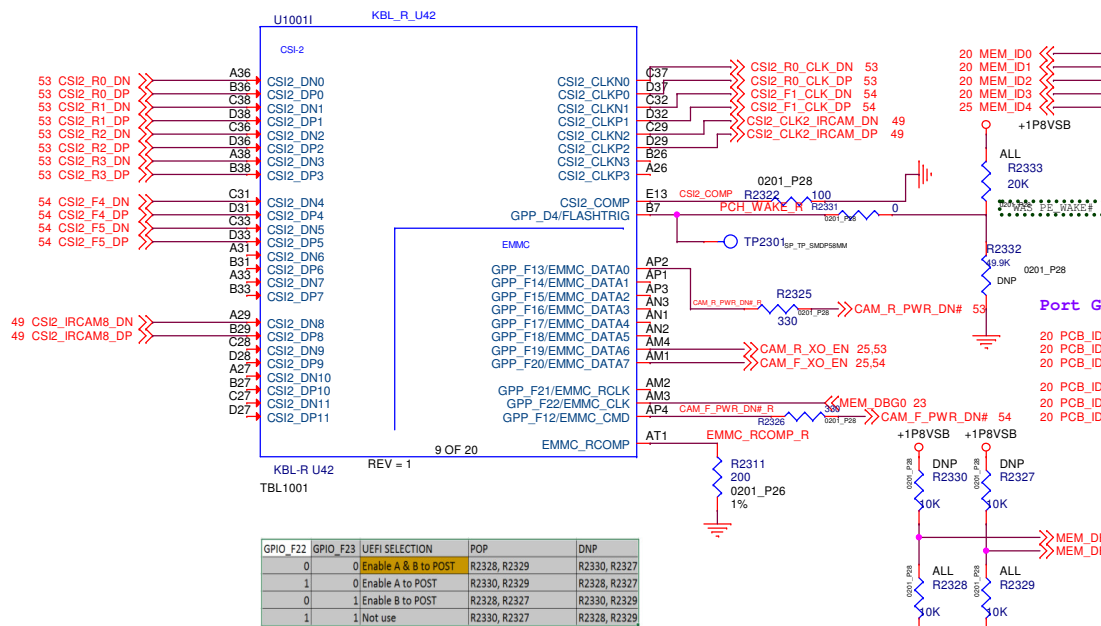






**TBL2301**

Build	X861217-001 Qty (10K 0201)	PCH_Value	PCH_10K	PCH_NOSTUFF
EVO.9	4	0000	R2302,R2308,R2309,R2310	R2304,R2305,R2306,R2307
EV1.0	4	0001	R2304,R2308,R2309,R2310	R2302,R2305,R2306,R2307
DV-DBG	4	0010	R2302,R2306,R2309,R2310	R2304,R2305,R2307,R2308
DV-RETAIL	4	0011	R2304,R2306,R2309,R2310	R2302,R2305,R2307,R2308
	4	0100	R2302,R2305,R2308,R2310	R2304,R2306,R2307,R2309
	4	0101	R2304,R2305,R2308,R2310	R2302,R2306,R2307,R2309
RSVD Calgary MP	4	0110	R2302,R2305,R2306,R2310	R2304,R2307,R2308,R2309
	4	0111	R2304,R2305,R2306,R2310	R2302,R2307,R2308,R2309
	4	1000	R2302,R2307,R2308,R2309	R2304,R2305,R2306,R2310
	4	1001	R2304,R2307,R2308,R2309	R2302,R2305,R2306,R2310
	4	1010	R2302,R2306,R2307,R2309	R2304,R2305,R2308,R2310



## TBL2302

Reference Info Only. For Build Options used for LPDDR3, see TBL1601 on Sheet 16.

RAM Speed		RAM Size & Cal				DRAM Mfr				
MEM_ID4		MEM_ID3		MEM_ID2			MEM_ID1		MEM_ID0	
ID4_H	R2321	ID3_H	R2319	ID2_H	R2320	ZQ1	ID1_H	R2315	ID0_H	R2318
ID4_L	R2314	ID3_L	R2313	ID2_L	R2312	R1602,R1604, R1702,R1704	ID1_L	R2316	ID0_L	R2317
1600MHz	0	0x00		4GB		X887566-001	0x00		Hyn 2ynm	
1866MHz	1	0x01		8GB		for	0x01*		Sam D23*	
		0x02		16GB		Mem > 4 GB	0x02*		Sam D20*	
		0x03		RFU			0x03		Hyn 2znm	

Note: For Samsung 16GB, MEM ID is 0x01 for D20 parts (No Sam D23)









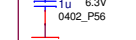


Table 52-10. Filter Requirements for SKL U PCH (Sheet 1 of 2)

Supply	Value	Quantity	Type (Pin Type)	Notes	Placement
VccLK15 (Pin L15) Note 1, 3	2.2 uH	1	Series Inductor 0603	Rated at least 100 mA DCR = 0.33ohm +/- 30%	<100 mils (2.54 mm) from edge of package
	22 uF	2	Filter Capacitor (Vss) 0603	20%	
VccAMPHYLL (Pin K15, L15) Note 1, 3	2.2 uF	1	Series Inductor 0603	Rated at least 100 mA DCR = 0.33ohm +/- 30%	
	22 uF	2	Filter Capacitor (Vss) 0603	20%	
VccLK2 (Pin K19) Note 1, 3	2.2 uF	1	Series Inductor 0603	Rated at least 100 mA DCR = 0.33ohm +/- 30%	
	22 uF	2	Filter Capacitor (Vss) 0603	20%	
VccLK4 (Pin N20) Note 1, 3	2.2 uH	1	Series Inductor 0603	Rated at least 100 mA DCR = 0.33ohm +/- 30%	
	22 uF	2	Filter Capacitor (Vss) 0603	20%	

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D

D

C

C

B

B

A

A

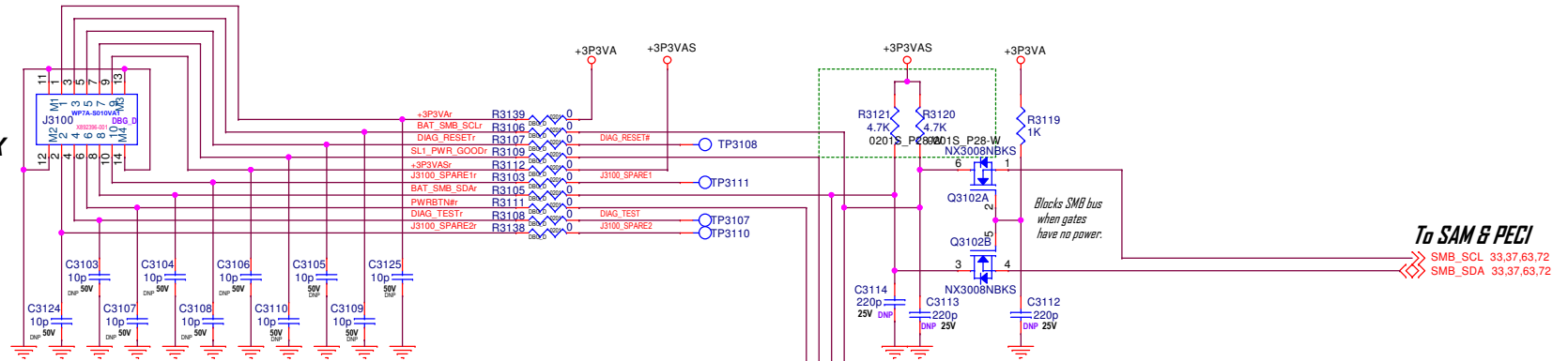
W x H 377 x 244 mm

```
Part C
Blade Power (for i7, EDRAM)
+1P8VSB
SSD
Wifi
```

**W x H 377 x 244 mm**



To  
Diagnostic Flex



To SAM & PECI

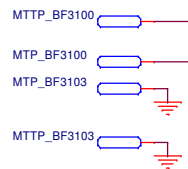
SMB\_SCL 33,37,63,72  
SMB\_SDA 33,37,63,72

To Battery & Fuel Gauge

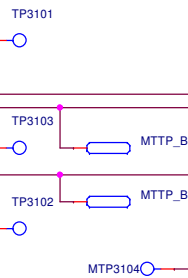
BAT\_SMB\_SCL 70  
BAT\_SMB\_SDA 70  
SL1\_PWR\_GOOD 35,55,70  
PWRBTN# 18,33,35

Changed button Pullups & Caps  
to reduce leakage & retain  
debounce filtering

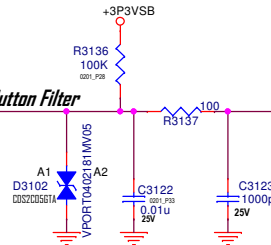
Power Button Filter



Volume Up Button Filter

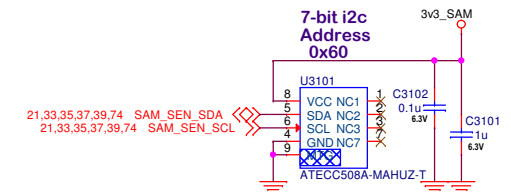


Volume Down Button Filter



To  
ButtonFlex

20160320js2256  
This pinout will allow use of the Peregrine flexes in the DevKits.  
The Y location of the connector is different between the two.

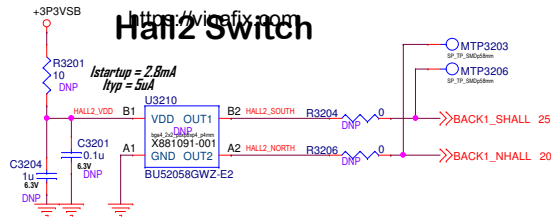


20160822js1414  
Title is: Button & Diagnostic Conn

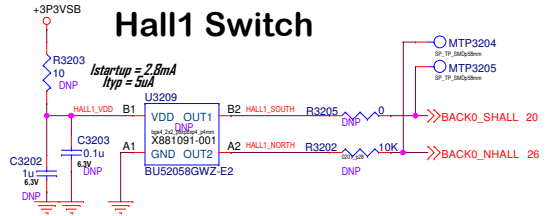
Report errors to Steven

# Ambient Light Sensor & Front Mic

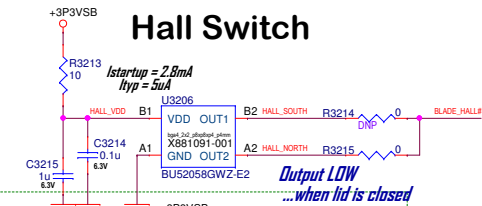
## Hall2 Switch



## Hall1 Switch

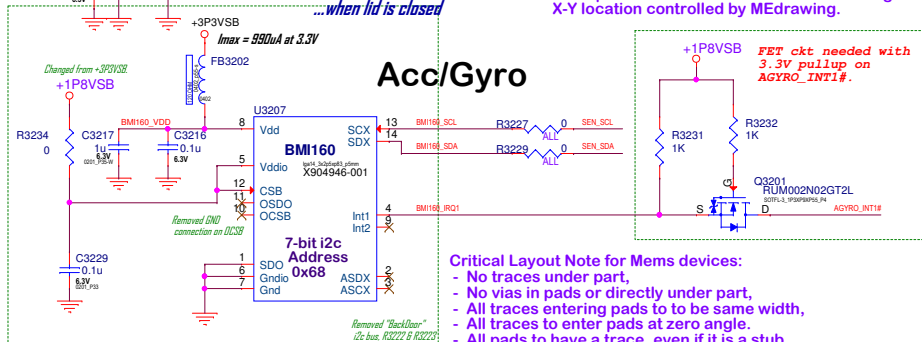


## Hall Switch



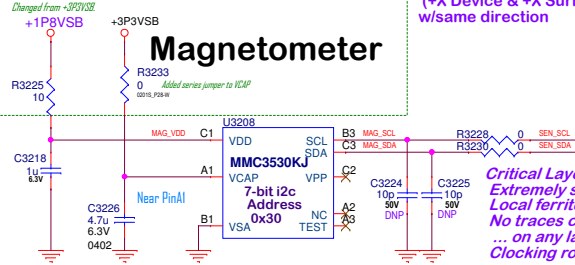
Output LOW  
...when lid is closed

## Acc/Gyro

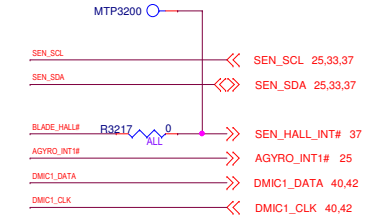
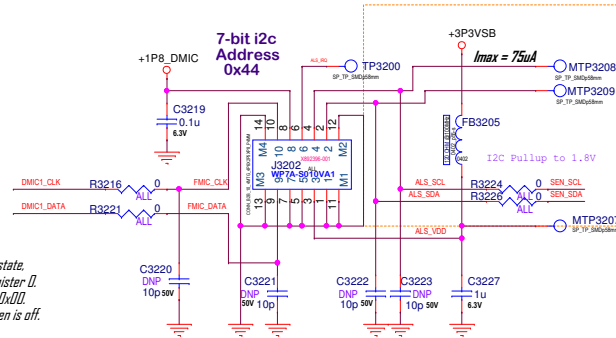


**Critical Layout Note for Mems devices:**  
- No traces under part,  
- No vias in pads or directly under part,  
- All traces entering pads to be same width,  
- All traces to enter pads at zero angle.  
- All pads to have a trace, even if it is a stub  
Clocking rotation controlled by MEDrawing.  
(+X Device & +X Surface vectors must be parallel w/same direction

## Magnetometer



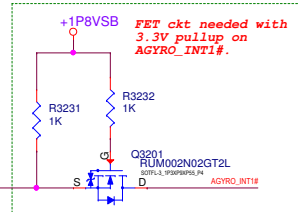
**Critical Layout Note:**  
Extremely sensitive to ferrous materials:  
Local ferrite bead to be >8mm remote  
No traces carrying >8mA within 10mm  
... on any layer.  
Clocking rotation controlled by MEDrawing.



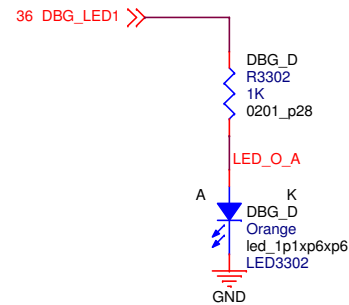
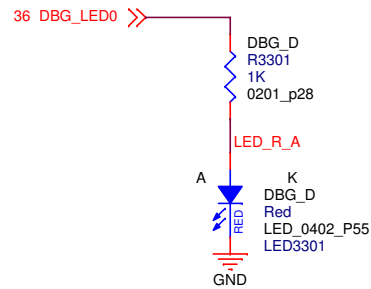
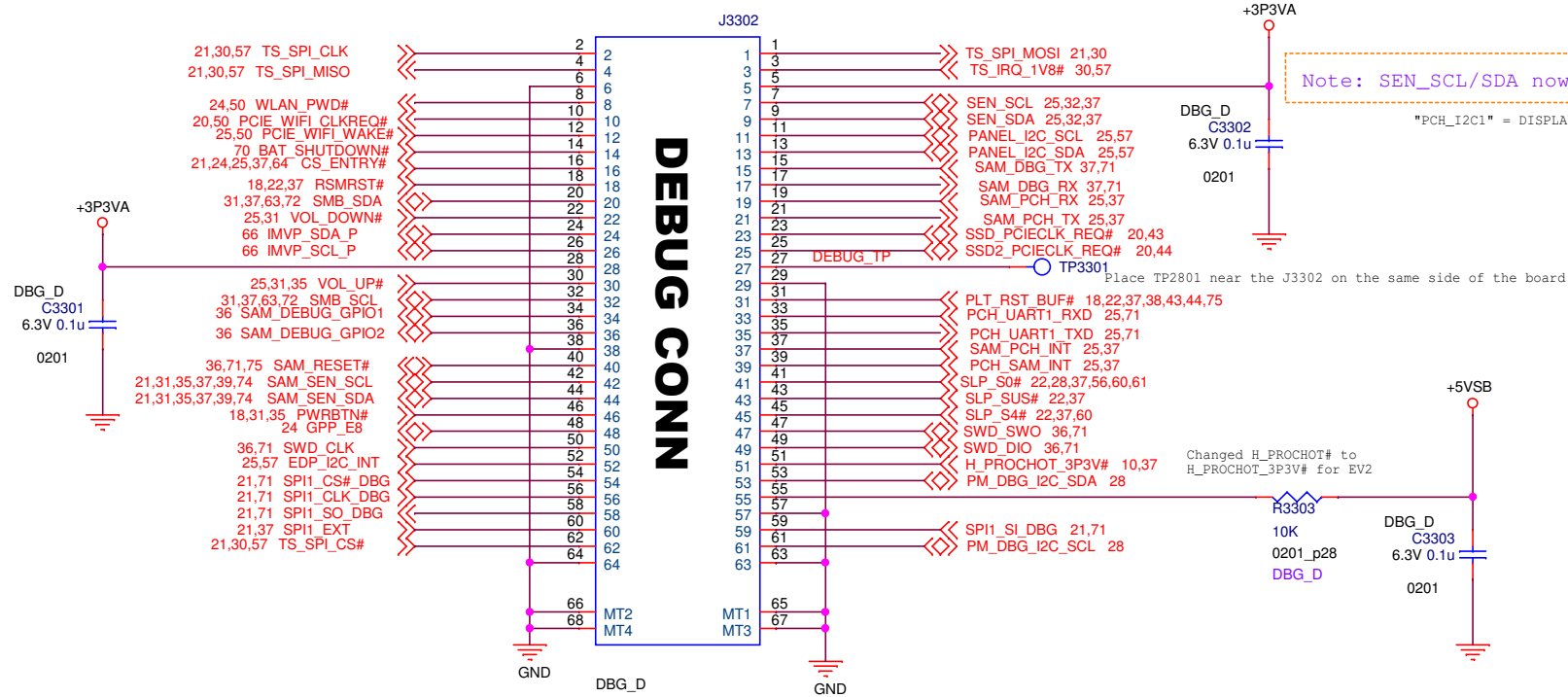
**Power-Down**  
To put the ISL29033 into a power-down state,  
the user can set [7 to 5] bits to 0 in Register 0.  
Or more simply, set all of Register 0 to 0x00.  
This should be the default when the screen is off.

**ALS field of view to be >55 degrees Half Angle Half Power**  
To achieve this FOV  
- assuming a 48+/-6um hole array on 150um centers contained in 4.3mm aperture,  
- the top of the ALS chip should reside 1100um below the glass.  
This should provide transmissivity [6% > T(lambda) > 10.5% for [390nm < lambda < 1000nm].  
It would be prudent to control the whole array using 30 random samples of 5 wholes measured by CMM/OMM

**Critical Layout Note:**  
Sensitive to ferrous materials  
Do not mount under a steel shield can  
If mounted on Glass side of board,  
Trigger may occur  
as early as 30Gauss North B-field  
or as late as 50Gauss North B-field  
Be careful not to mount within 15mm  
of speaker autofocus camera or other magnet.  
X-Y location controlled by MEDrawing.



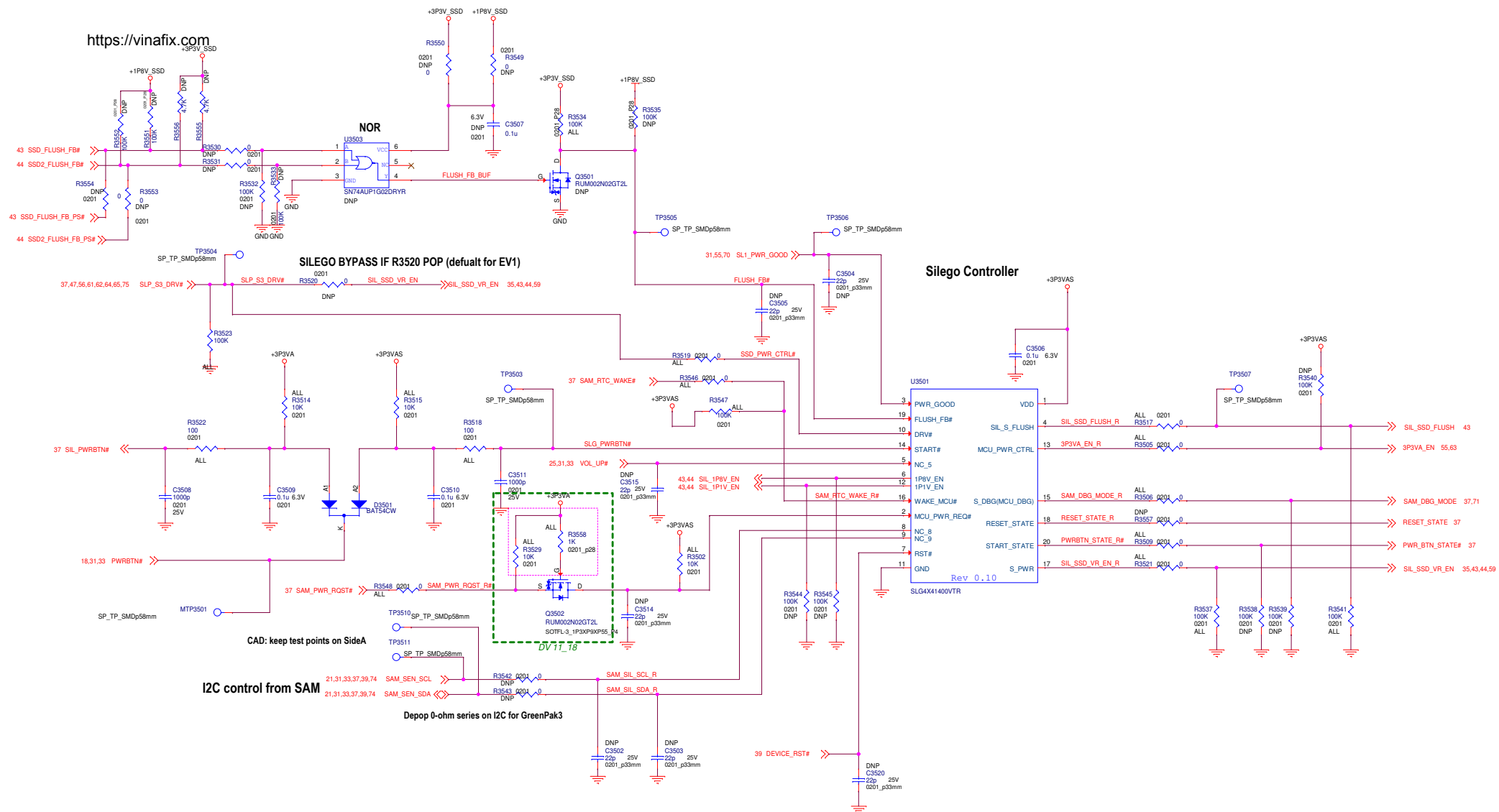




Place LEDs outside shield can for visibility outside of bucket ktc - 02/22/2016

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REMOVED PECI



**System Aggregator Microprocessor**

**Madera EV0.9**

*C3612, C3616 MSPN manually changed to X894056-001 per Calgary MP*

*MCRB ECO-00020898*

*Removed R3613 for EV DVE crystal testing.*

**Build**

Build	R3607	MSPN
EV0.9	80.6	X860461-001
EV1.0	169	X909593-001
DV-DBG	267	X806948-001
DV-RETAIL	383	X807226-001
	523	X800457-001
	698	X853019-001
	909	X807179-001

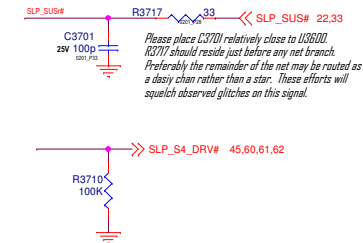
Build	R3607	MSPN
EV0.9	80.6	X860461-001
EV1.0	169	X909593-001
DV-DBG	267	X806948-001
DV-RETAIL	383	X807226-001
	523	X800457-001
	698	X853019-001
	909	X807179-001
	1180	X804207-001
	1500	X806696-001
	2000	X800427-001

Proc Type	R3608	MSPN
i5-8250U	80.6	X860461-001
i5-8350U	169	X909593-001
i7-8650U	267	X806948-001

### Uncommitted Pins



Note: SEN\_SCL/SDA now on +1P8VSB and cannot directly connect to SAM\_SEN\_SCL/SDA. Jumpers should be removed.



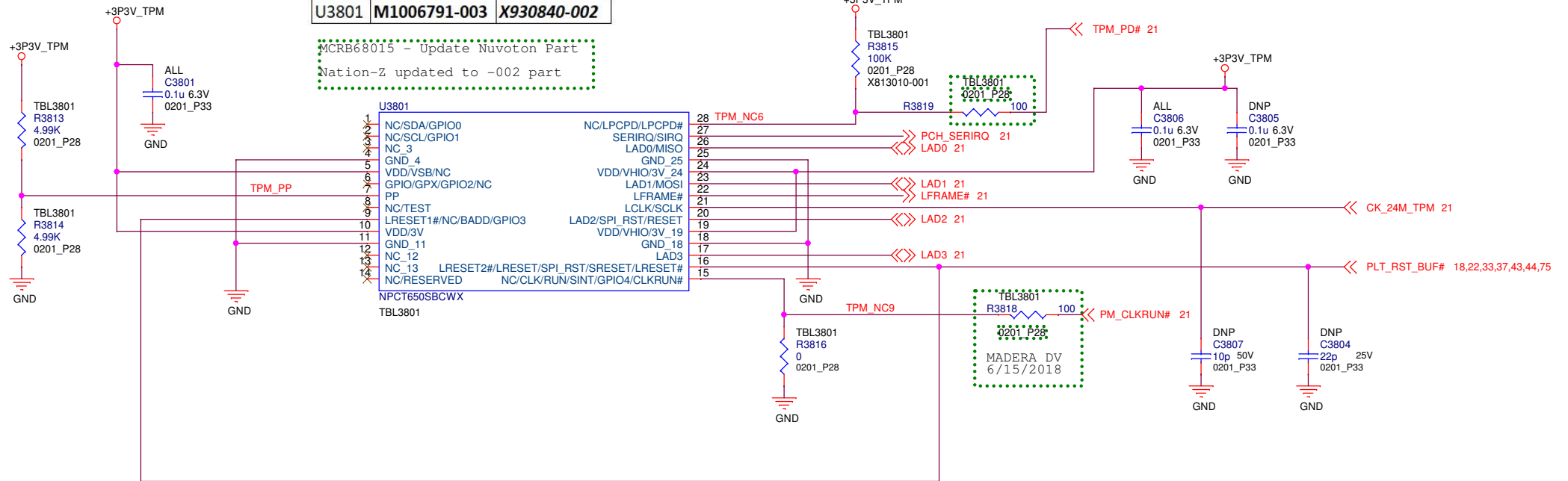
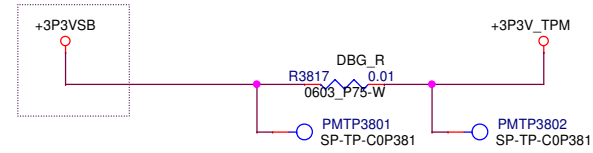
# Trusted Platform Module

## TBL3801

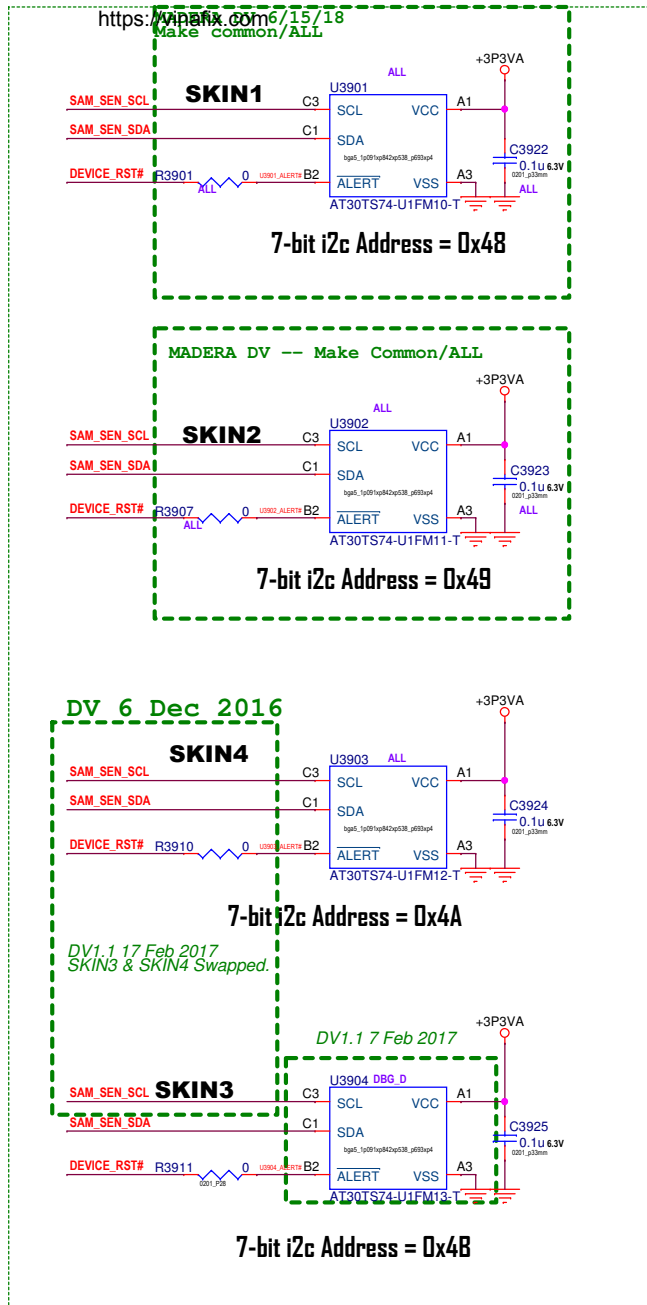
Ref	Nuvoton	NationZ
R2301	X811791-001	NO-STUFF
R2303	NO-STUFF	X811791-001
R3813	NO-STUFF	X813007-001
R3814	X813007-001	NO-STUFF
R3815	NO-STUFF	X813010-001
R3816	NO-STUFF	X811786-001
R3818	X811786-001	NO-STUFF
R3819	X811786-001	NO-STUFF
U3801	M1006791-003	X930840-002

MCRB68015 - Update Nuvoton Part  
Nation-Z updated to -002 part

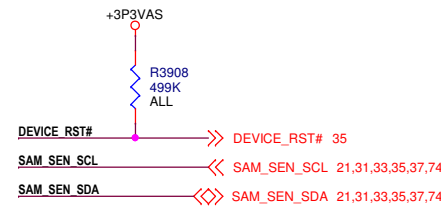
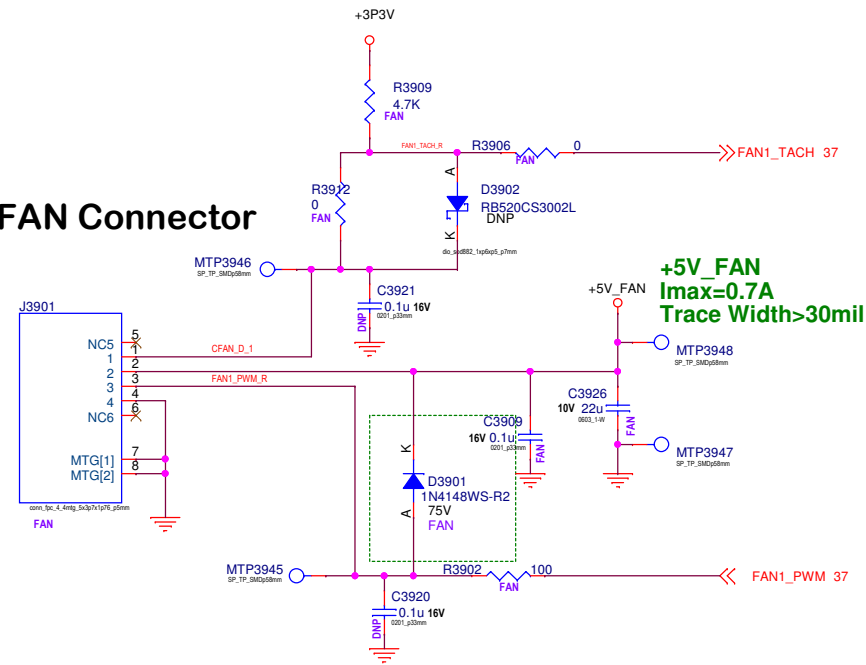
U3801	NC/LPCPD/LPCPD#
1 NC/SDA/GPIO0	28 TPM_NC6
2 NC/SCL/GPIO1	27 SERIRQ/SIRQ
3 NC_3	26 LAD0/MISO
4 GND_4	25 GND_25
5 VDD/VSB/NC	24 VDD/VHIO/3V_24
6 GPIO/GPX/GPIO2/NC	23 LAD1/MOSI
7 PP	22 LFRAME#
8 NC/TEST	21 LCLK/SCLK
9 LRESET1#/NC/BADD/GPIO3	20 LAD2/SPI_RST/RESET
10 VDD/3V	19 VDD/VHIO/3V_19
11 GND_11	18 GND_18
12 NC_12	17 LAD3
13 NC_13	16 LRESET2#/LRESET/SPI_RST/SRESET/LRESET#
14 NC/RESERVED	15 NC/CLK/RUN/SINT/GPIO4/CLKRUN#
NPCT650SBCWX	
TBL3801	



W x H 557 x 231 mm

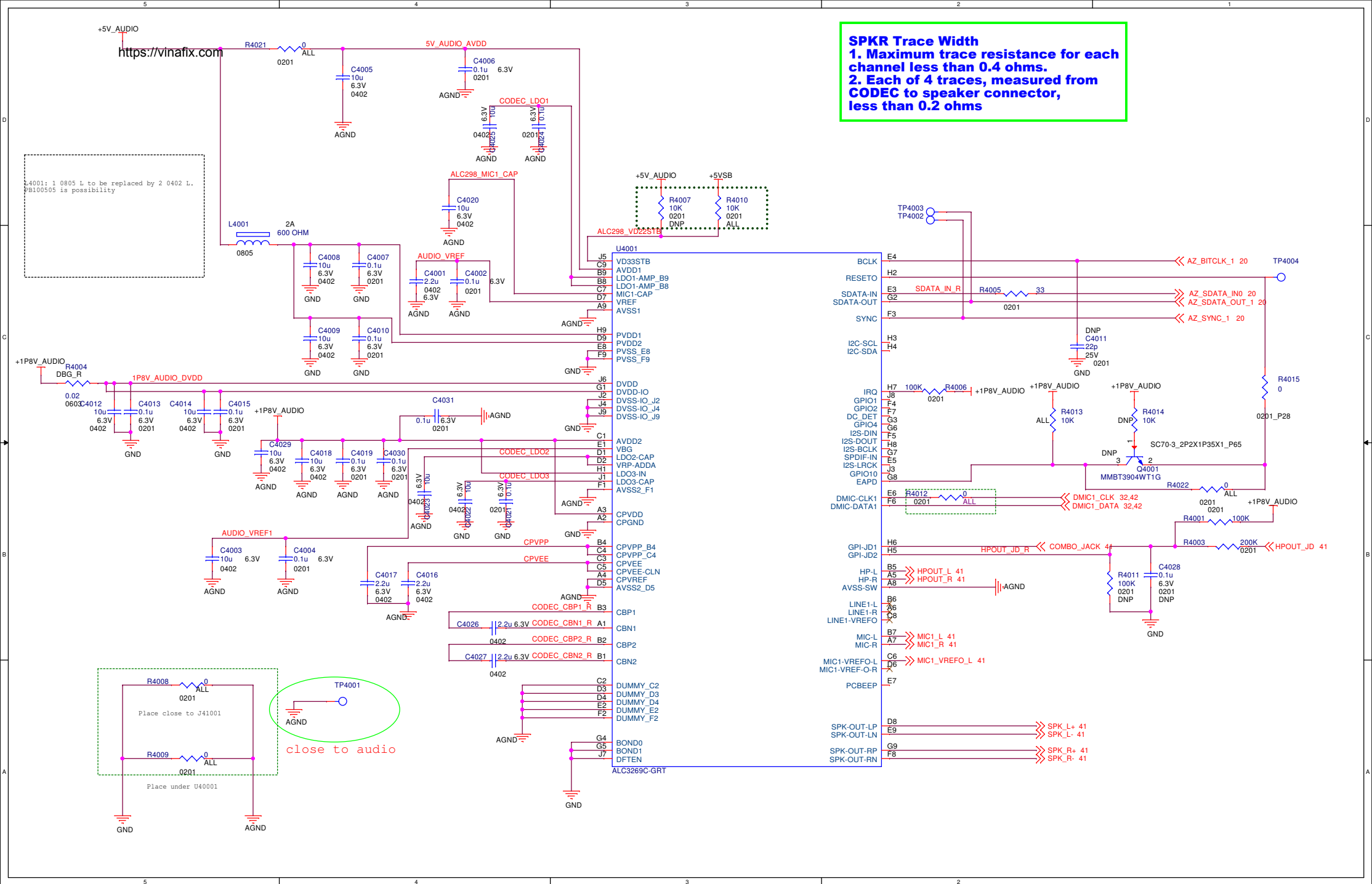


## FAN Connector



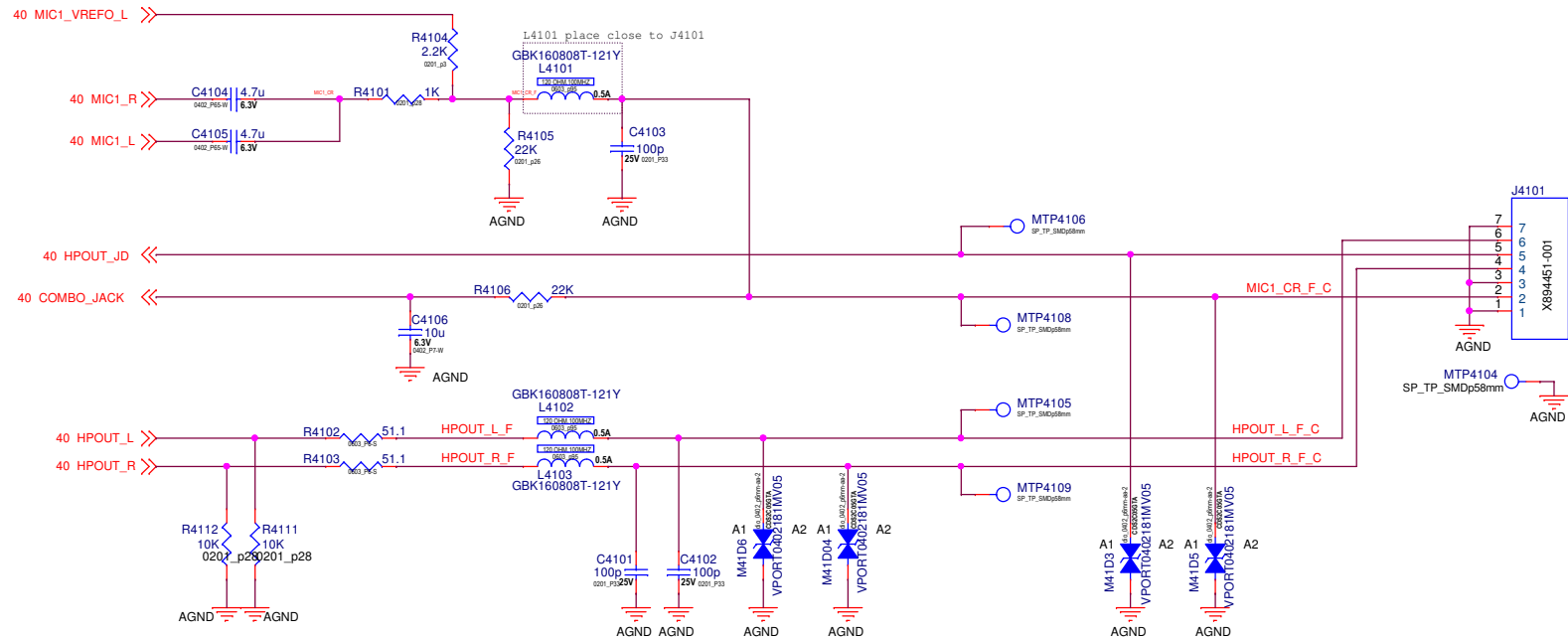
20160827/sjs0527: Temp Sensor/System Fan Report errors to Steven

W x H 387 x 250 mm



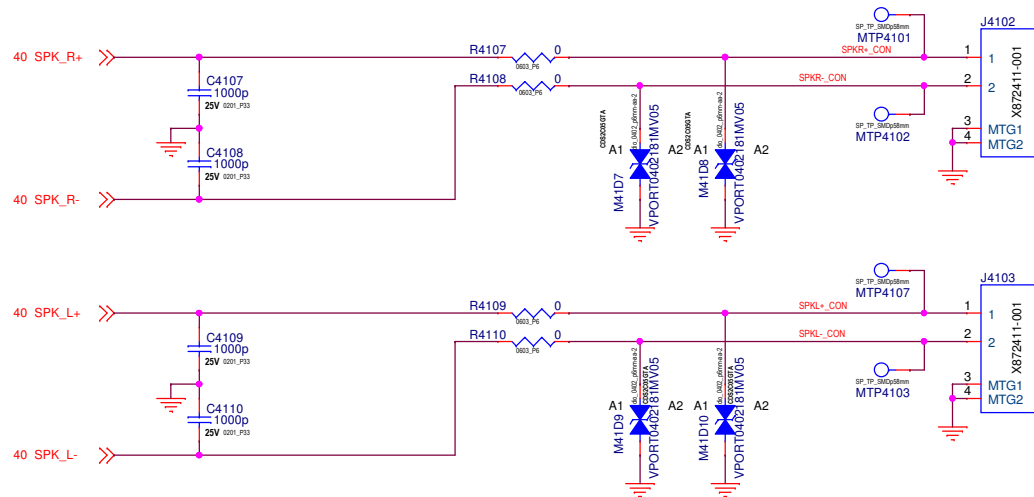


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Connector to  
AjackFlex

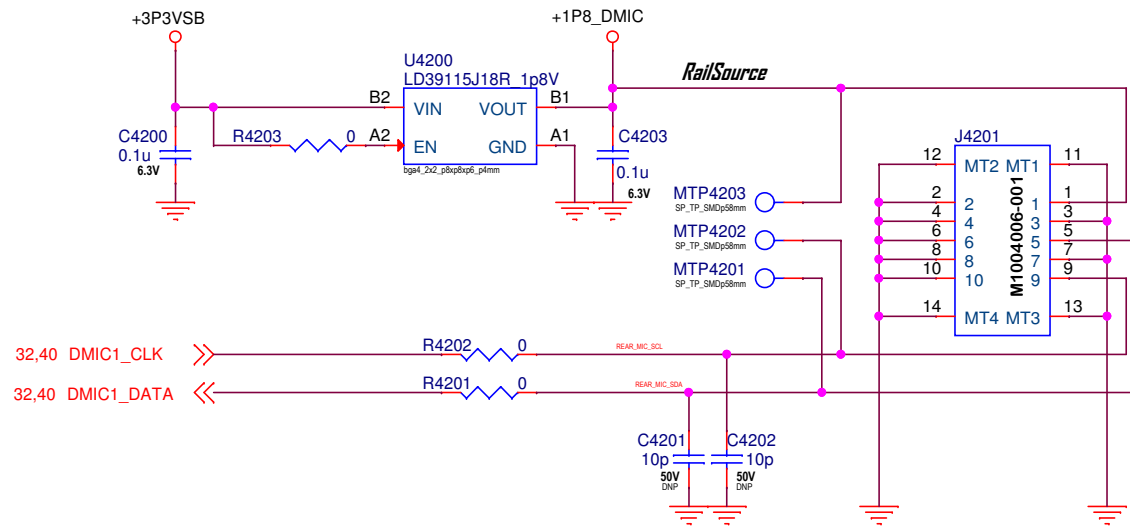
SK 0314: VPORT0402181MV05 diodes to be replaced



Right  
Speaker  
Connector

Left  
Speaker  
Connector

WxH 400x258.82mm



To  
RearMicFlex

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# TBL4301

RefDes	1x128GB_Tsh	1x256GB_Tsh	1x512GB_Tsh	1x128GB_Hynix	1x256GB_Hynix	1x512GB_Hynix	Zx512GB_Hynix	Domain
R4304	X859661-001	X859661-001	X859661-001	X859829-001	X859829-001	X859829-001	X859829-001	Core Voltage
U4301	M1075799-001 (K8G30ZP2128G)	M1075816-001 (K8G30ZP2256G)	M1075819-001 (K8G30ZP2512G)	M1080816-001 (HFB1M8MQ331A0MR)	M1080841-001 (HFB1M8MQ331A0MR)	M1080842-001 (HFB1M8MQ331A0MR)	M1080842-001 (HFB1M8MQ331A0MR)	SSD1

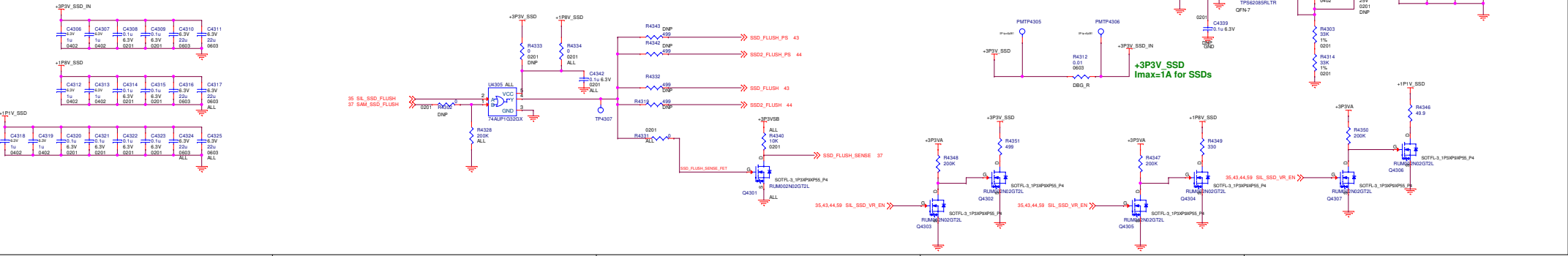
  

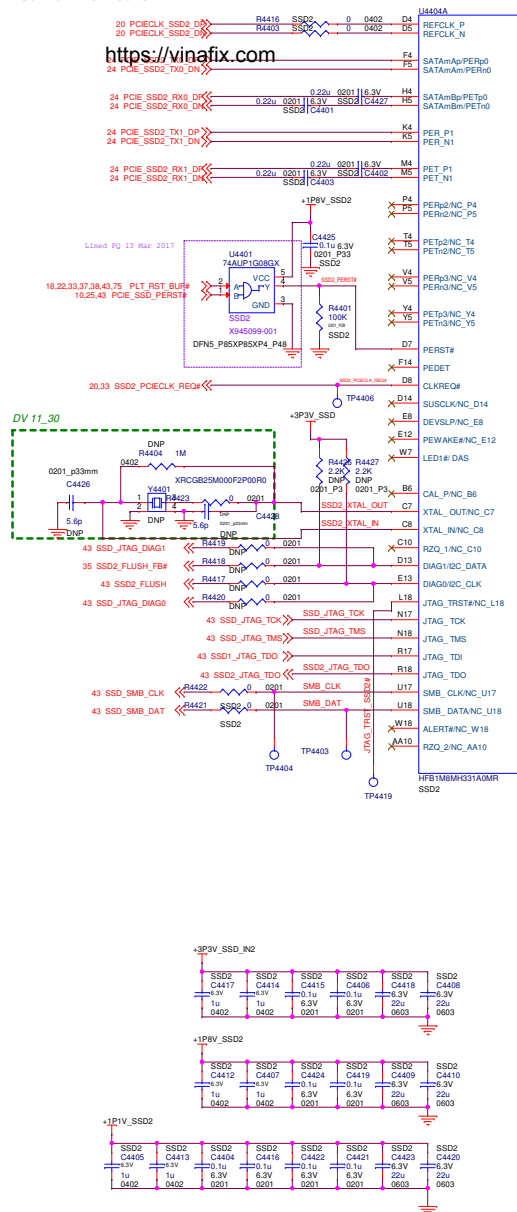
RefDes	1x128GB_Tsh	1x256GB_Tsh	1x512GB_Tsh	1x128GB_Hynix	1x256GB_Hynix	1x512GB_Hynix	Zx512GB_Hynix	Domain
P4301	X946298-001	X946298-001	X946298-001	X946298-001	X946298-001	X946298-001	X946298-001	Debug - JTAG connector
R4341	X813010-001	X813010-001	X813010-001	X813010-001	X813010-001	X813010-001	X813010-001	DEBUG - JTAG Pull-up
R4317	X800967-001	X800967-001	X800967-001	X800967-001	X800967-001	X800967-001	X800967-001	SSD1 - JTAG TDO
R4318	NO-STUFF	NO-STUFF	NO-STUFF	NO-STUFF	NO-STUFF	NO-STUFF	NO-STUFF	SSD2 - JTAG TDO

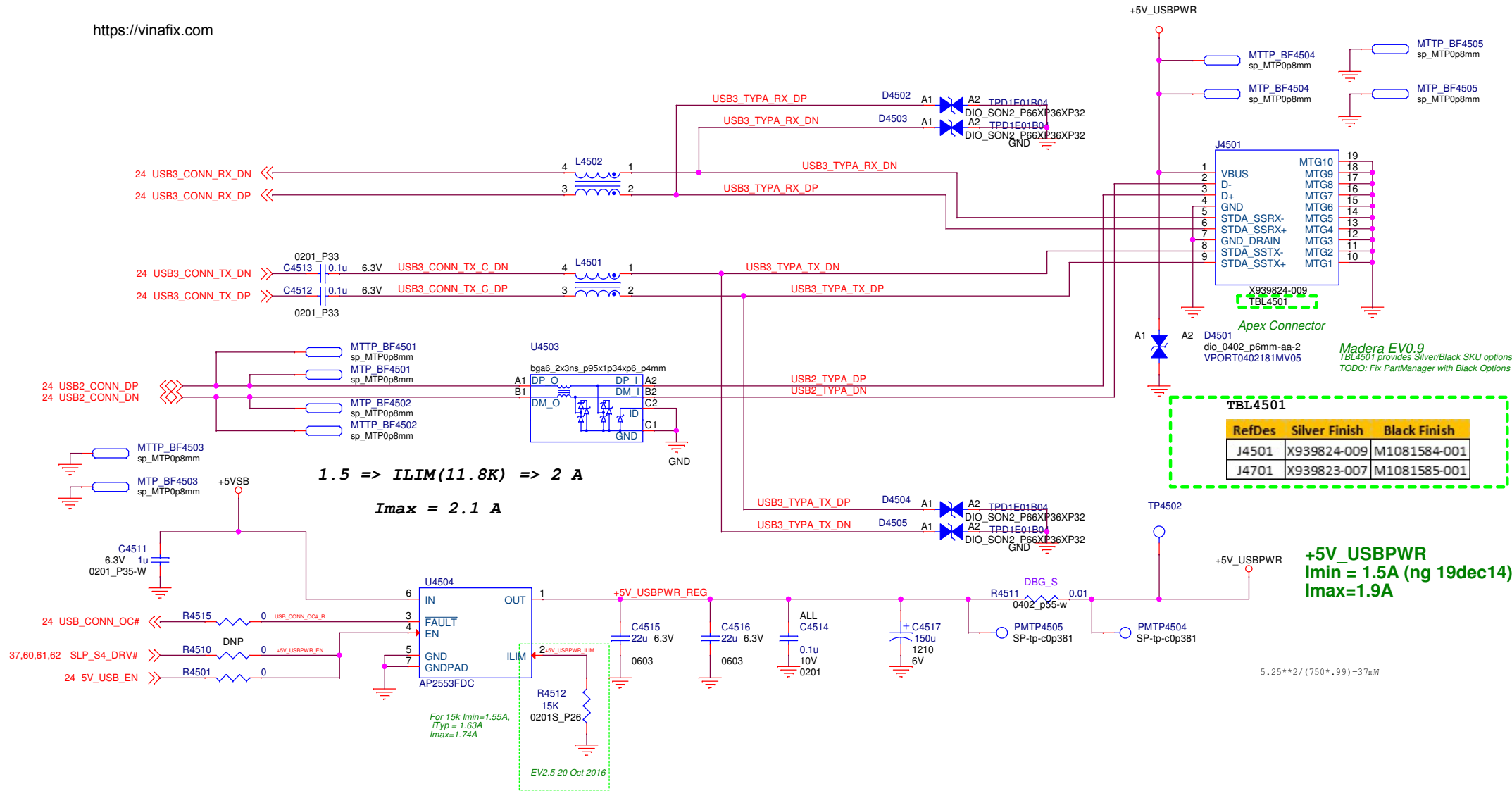


Single SSD  
Load R4317 and DNP R4318 for U4301  
loaded and U4404 DNP

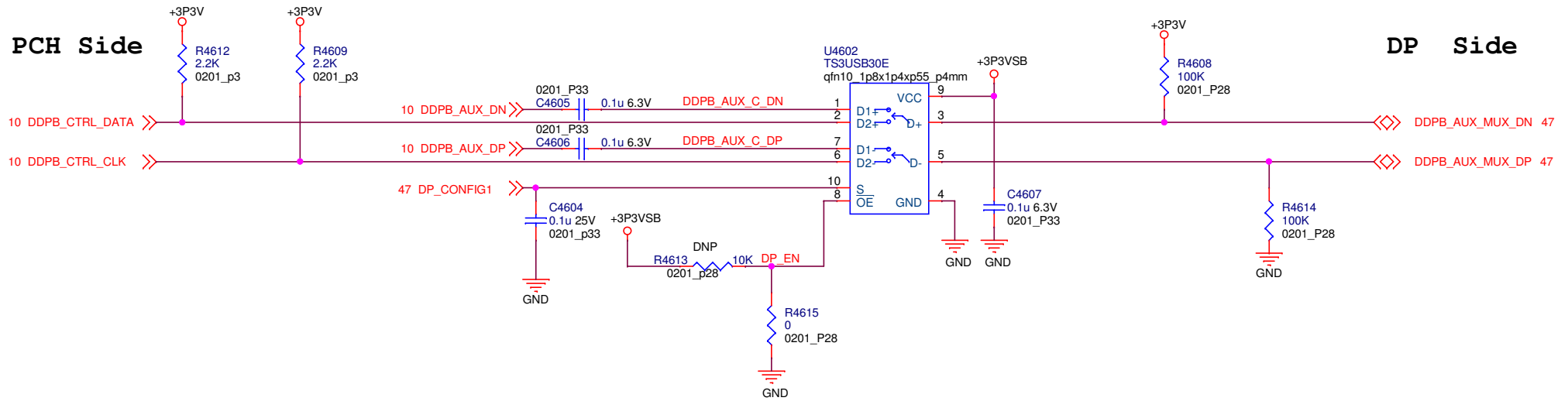
Dual SSD  
DNP R4317 and Load R4318  
for both U4301 and U4404 loaded.



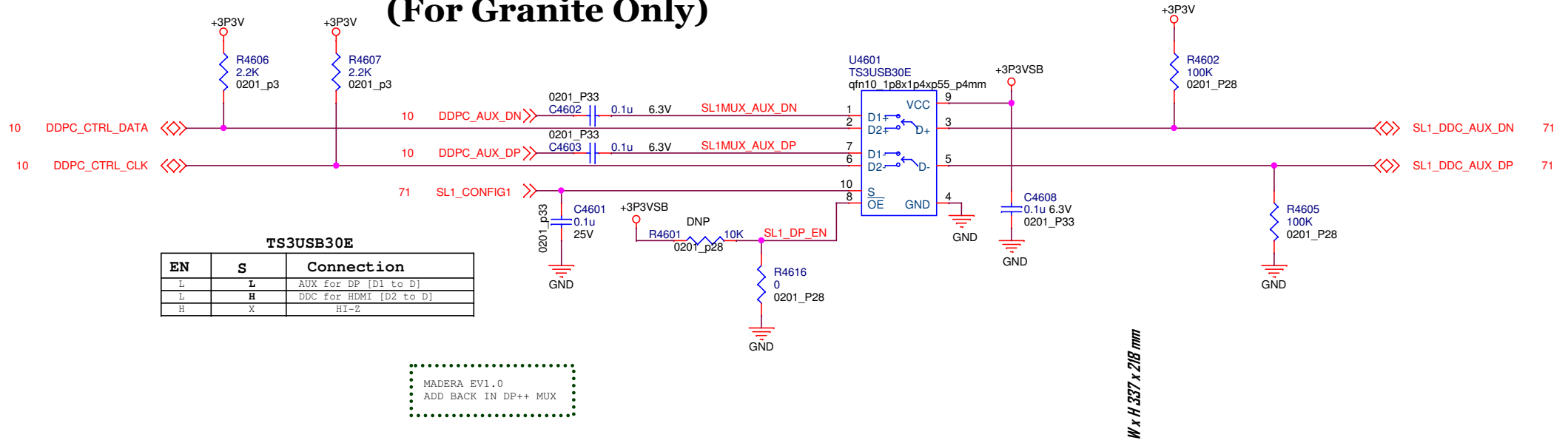




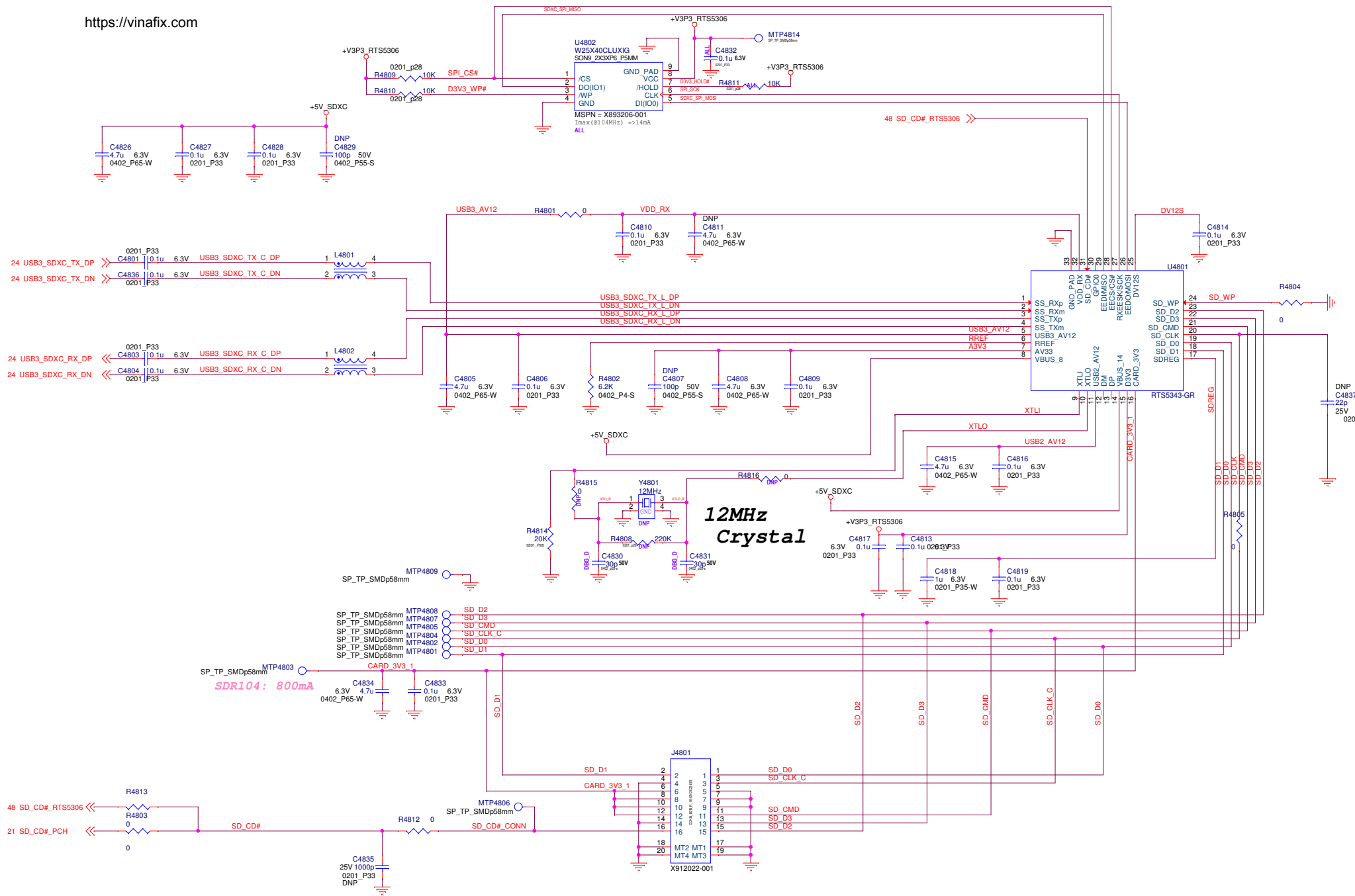
# mDP mux to HDMI/DVI Dongle control



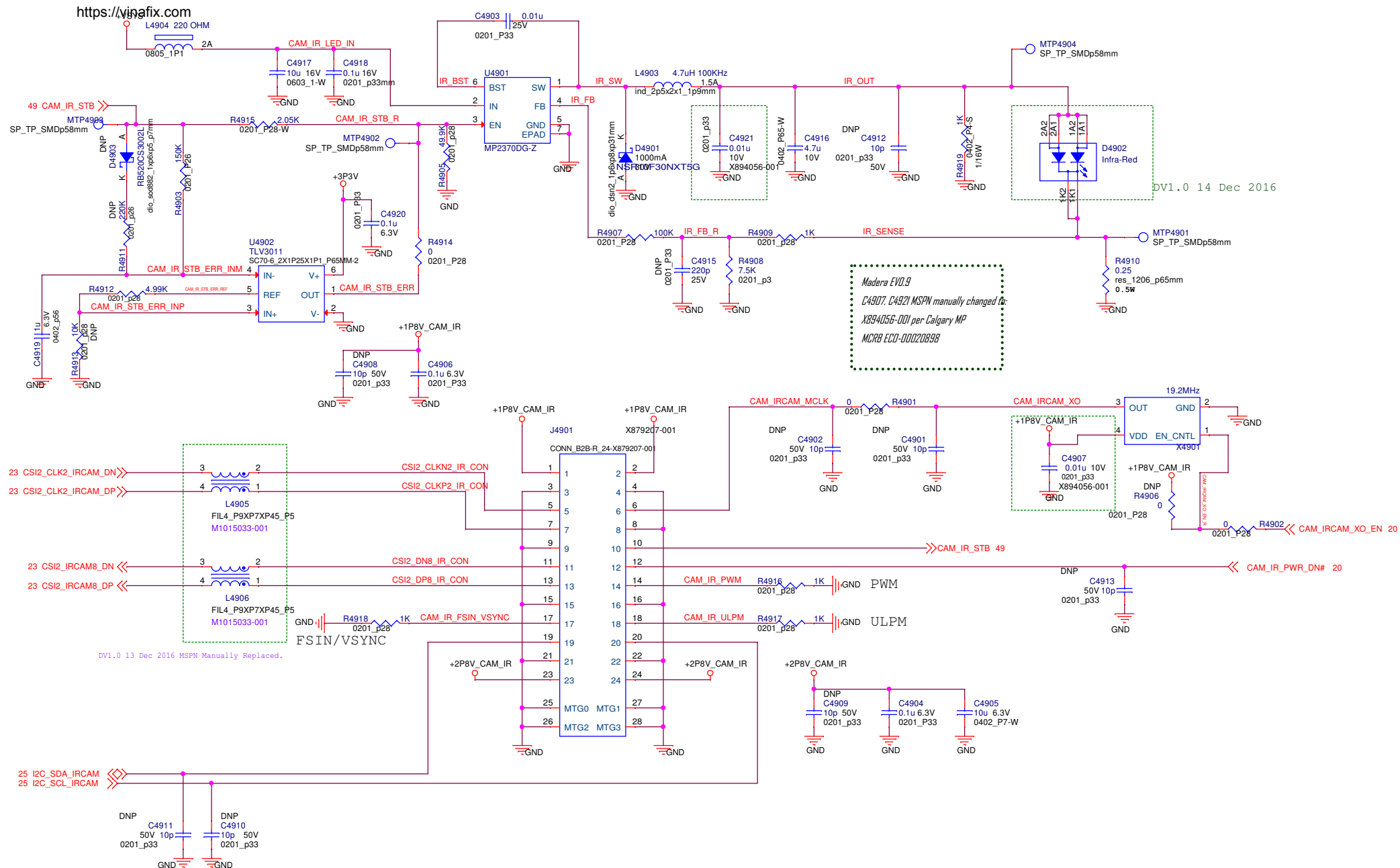
## SL1 DP mux to HDMI/DVI Dongle control (For Granite Only)

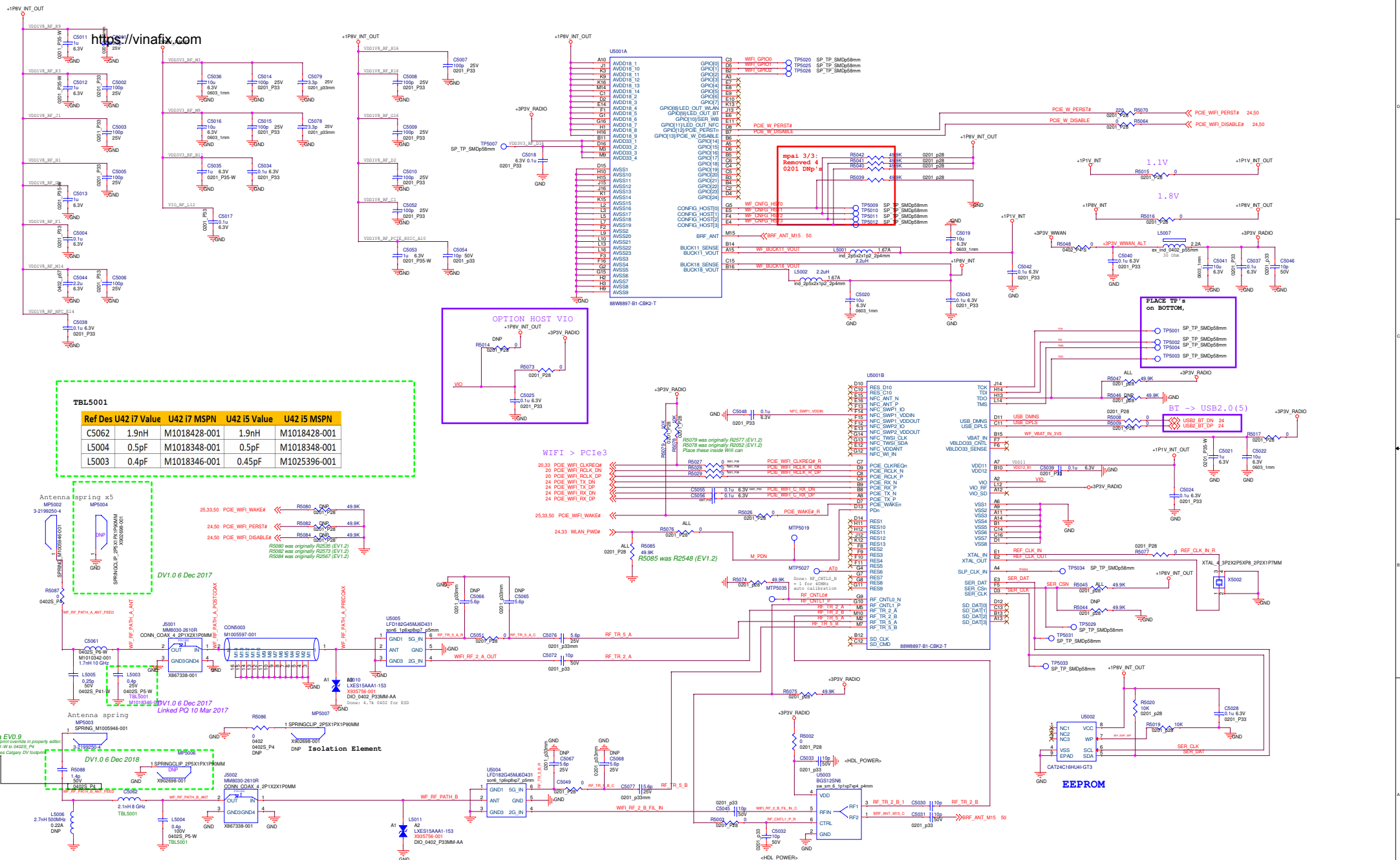




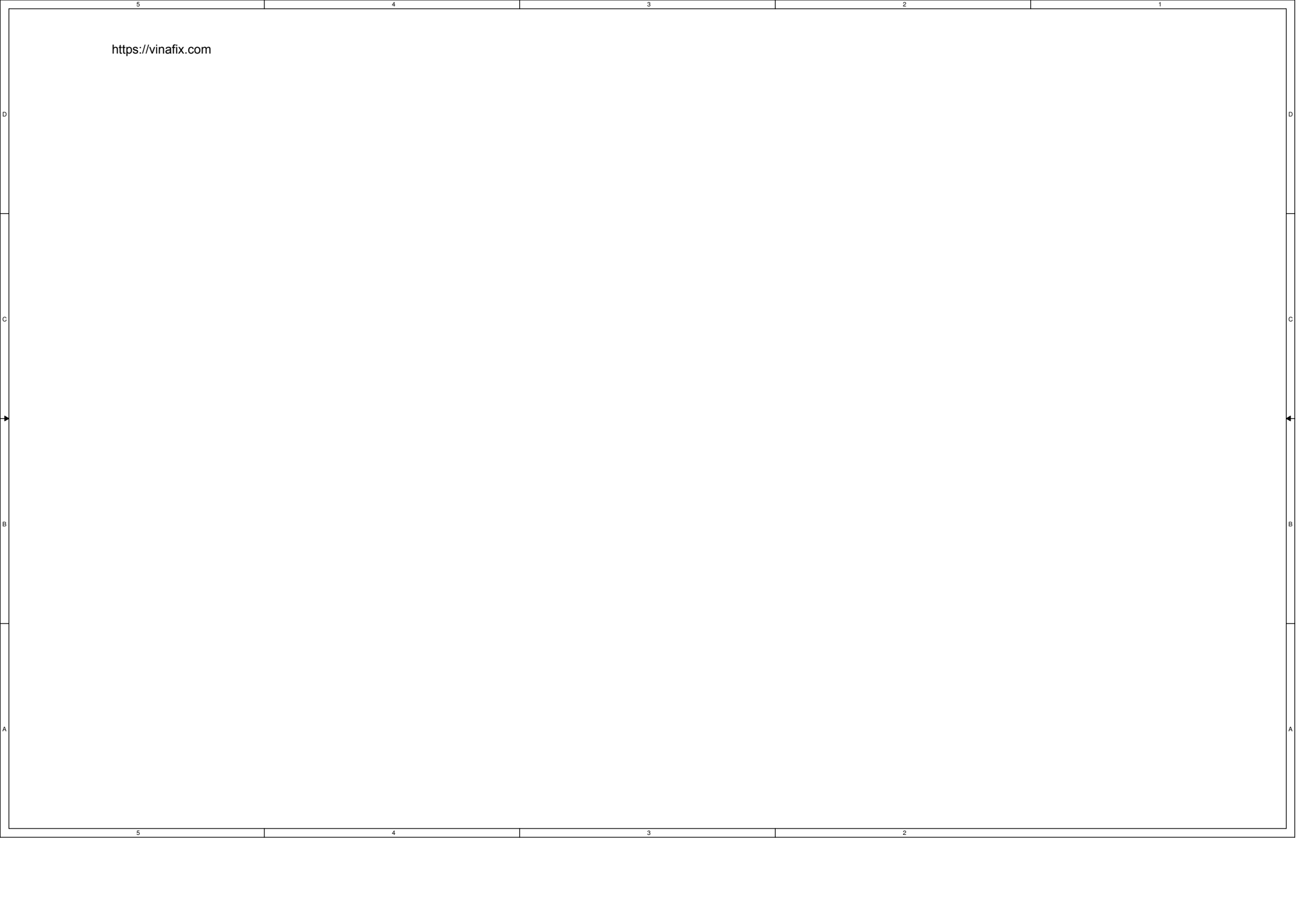




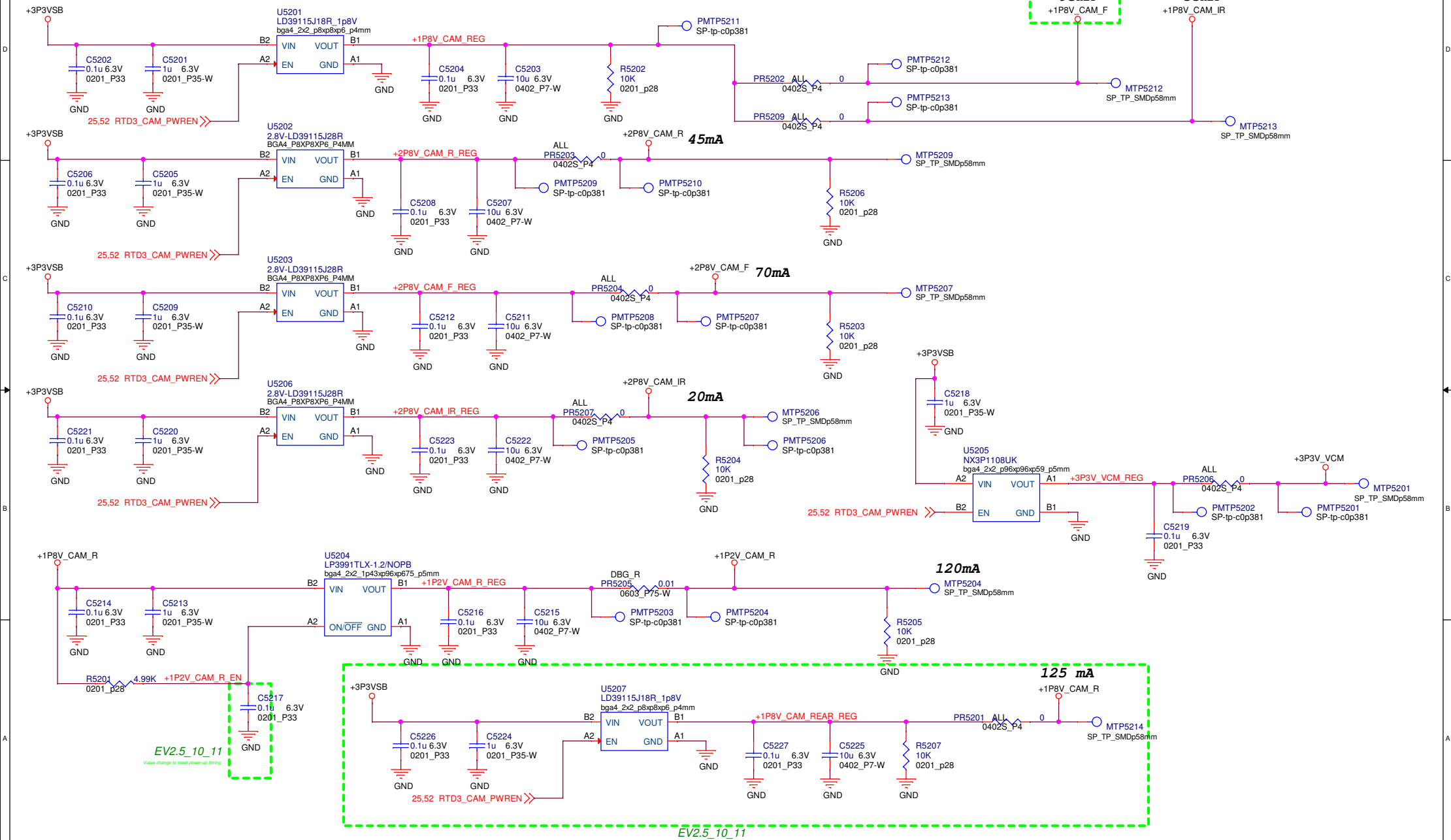


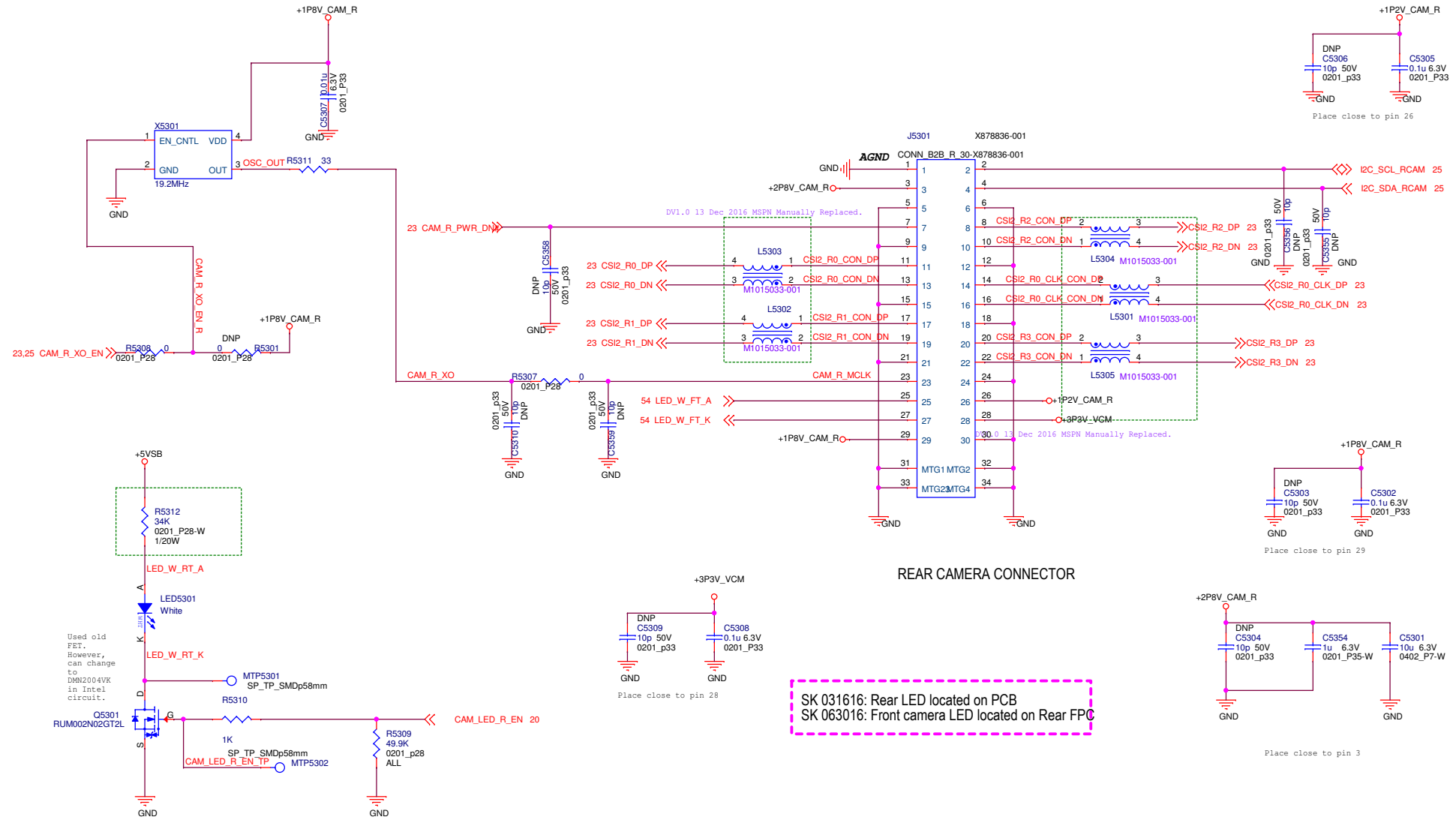


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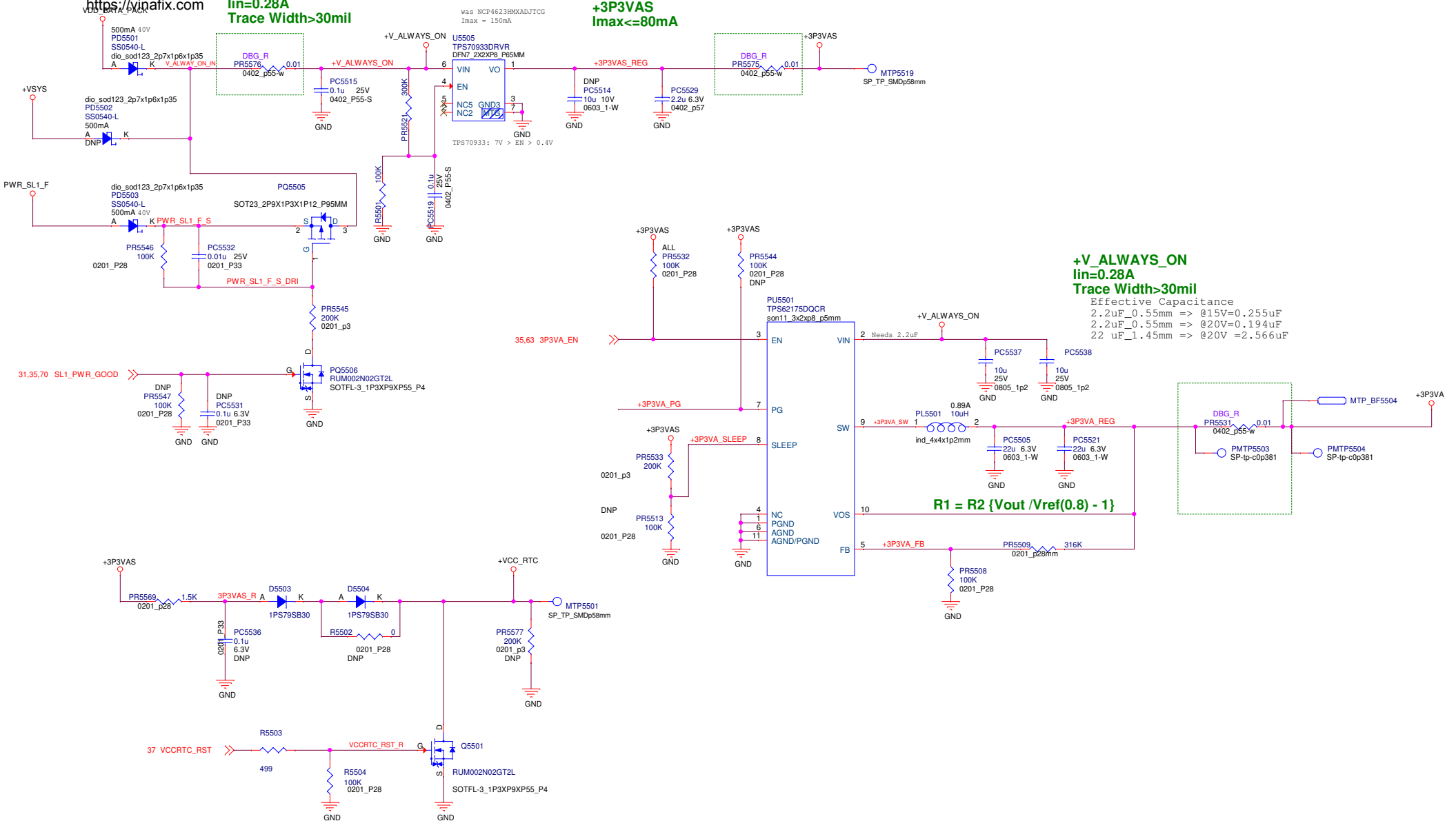
https://vinafix.com

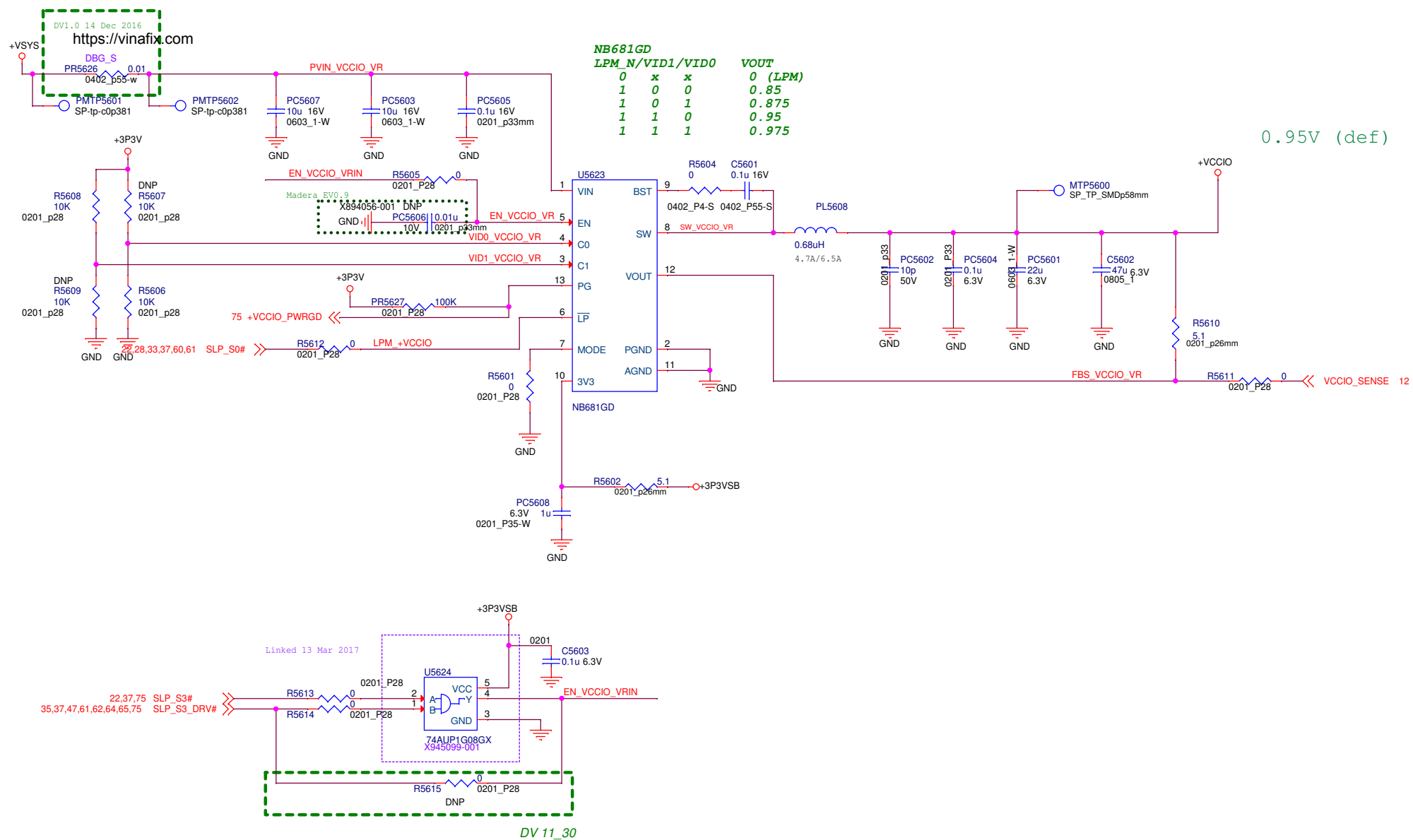
**+V\_ALWAYS\_ON**  
**Iin=0.28A**  
**Trace Width>30mil**

**+3P3VAS**  
**Imax<=80mA**

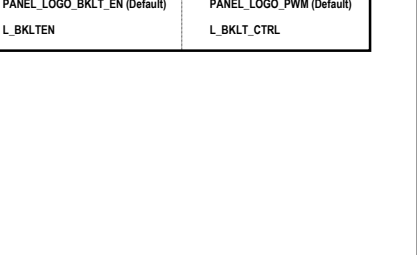
**+V\_ALWAYS\_ON**  
**Iin=0.28A**  
**Trace Width>30mil**  
Effective Capacitance  
2.2uF\_0.55mm => @15V=0.255uF  
2.2uF\_0.55mm => @20V=0.194uF  
22 uF\_1.45mm => @20V =2.566uF

$$R1 = R2 \{V_{out} / V_{ref}(0.8) - 1\}$$







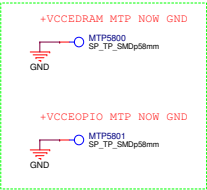


Sp (PIN8, PIN10) : Select Line	Dp (Pin 1) : Output	Dm (Pin 2) : Output
BL_INST_ON_HINDSHK = 0 (Default)	L_BACKLIGHT_EN = PANEL_LOGO_BKLT_EN (Default)	L_BACKLIGHT_PWM = PANEL_LOGO_PWM (Default)
BL_INST_ON_HINDSHK = 1	L_BKLTEN	L_BKLT_CTRL

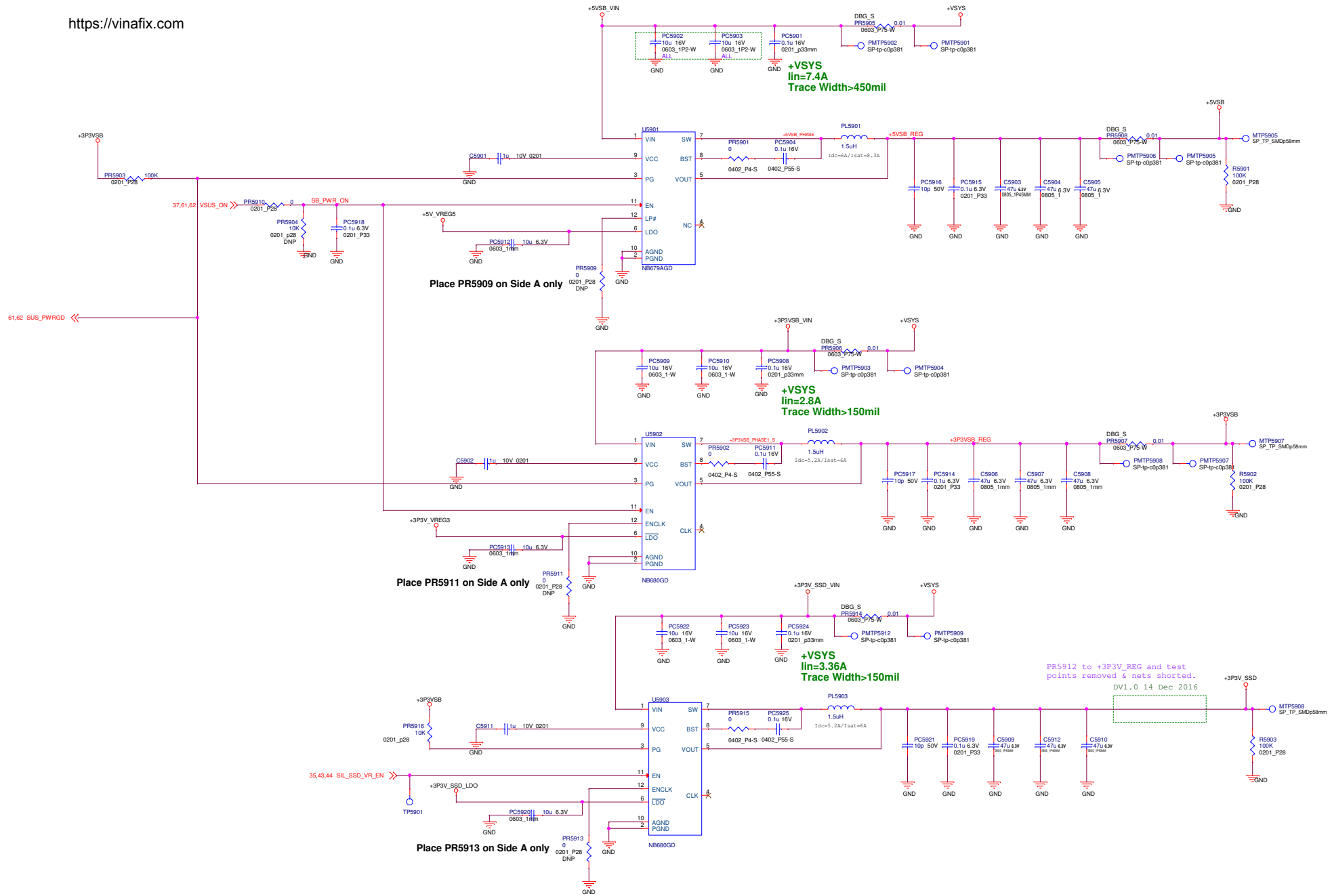
5 4 3 2 1

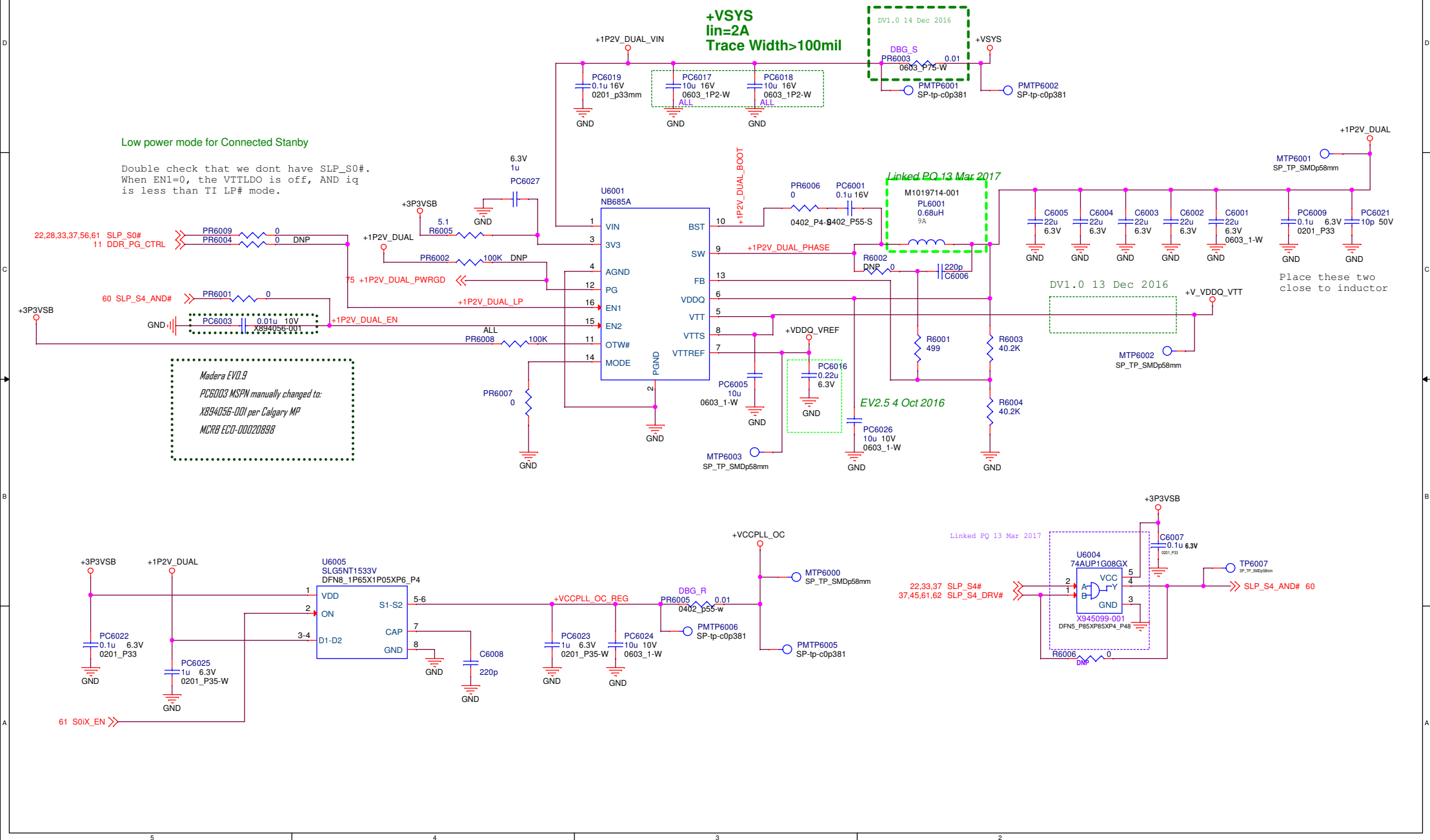
<https://vinafix.com>

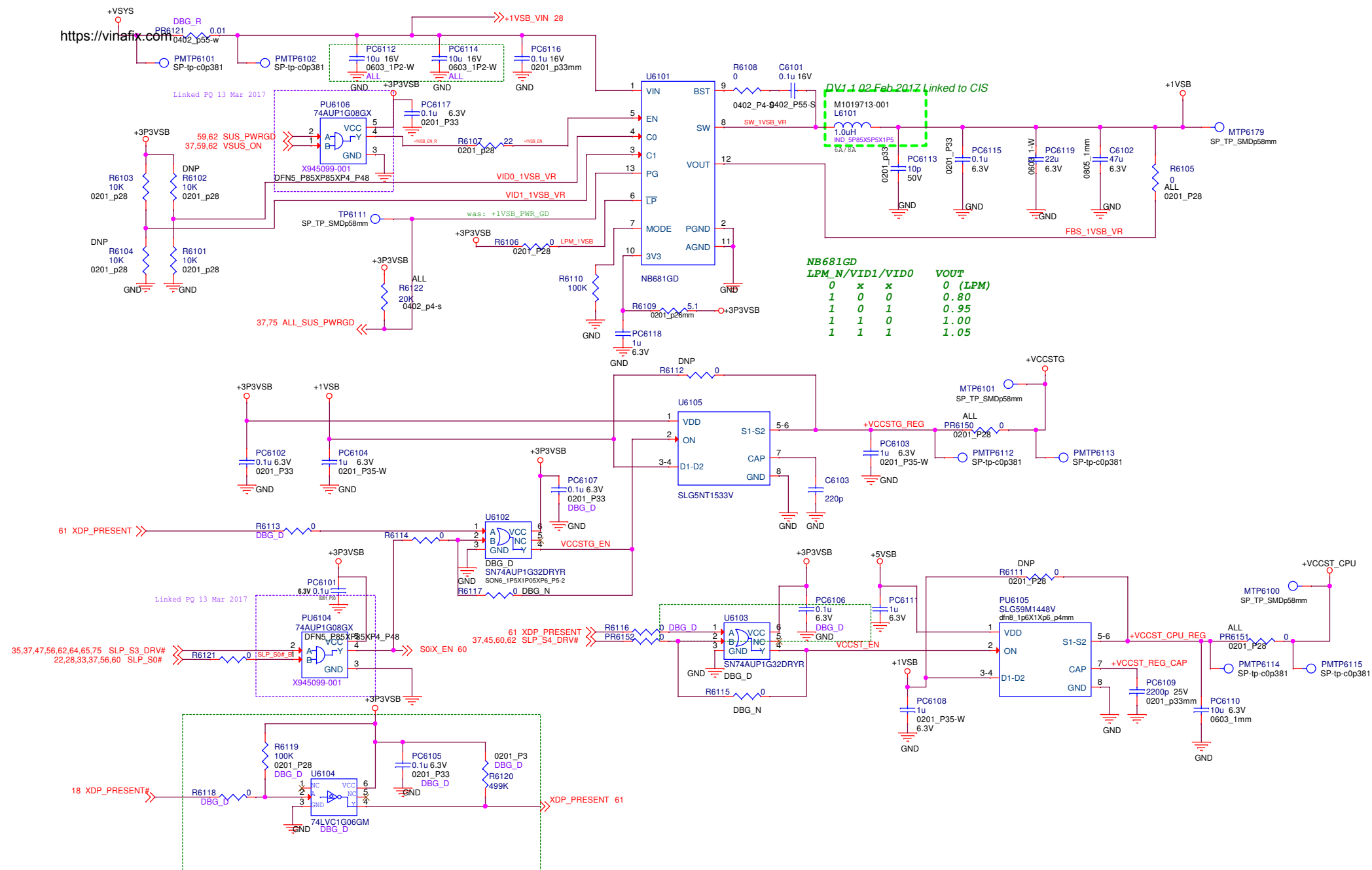
REMOVED +VCCEDRAM & +VCCEPIO RAILS



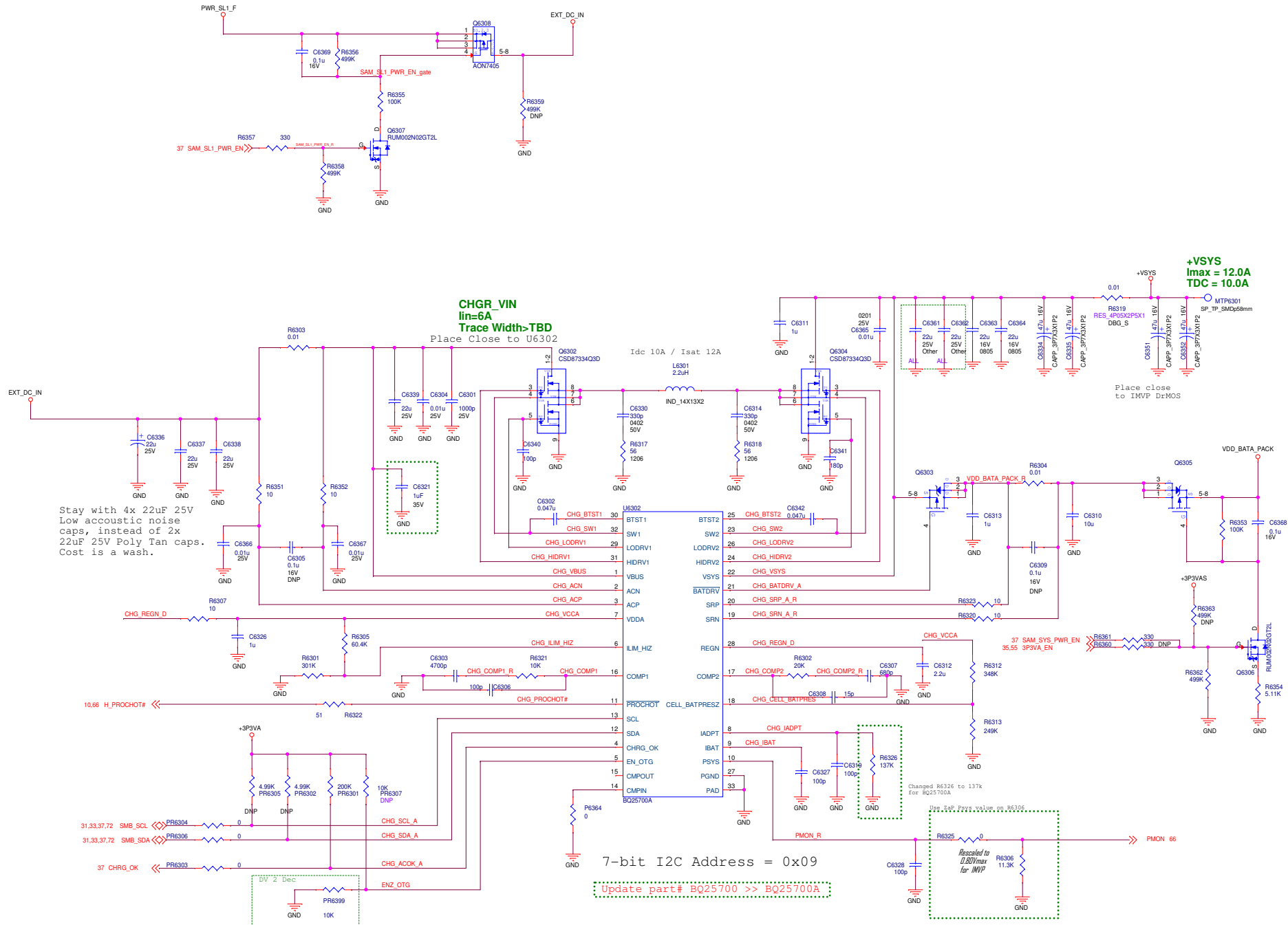
5 4 3 2

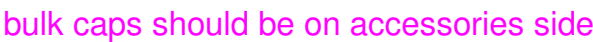






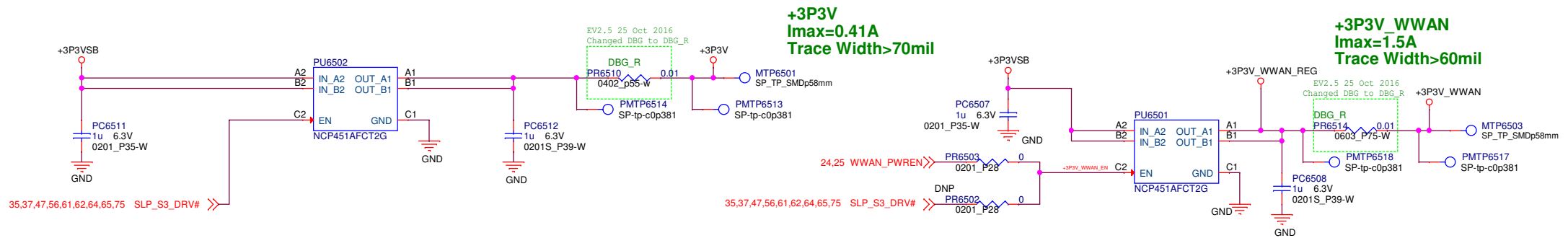
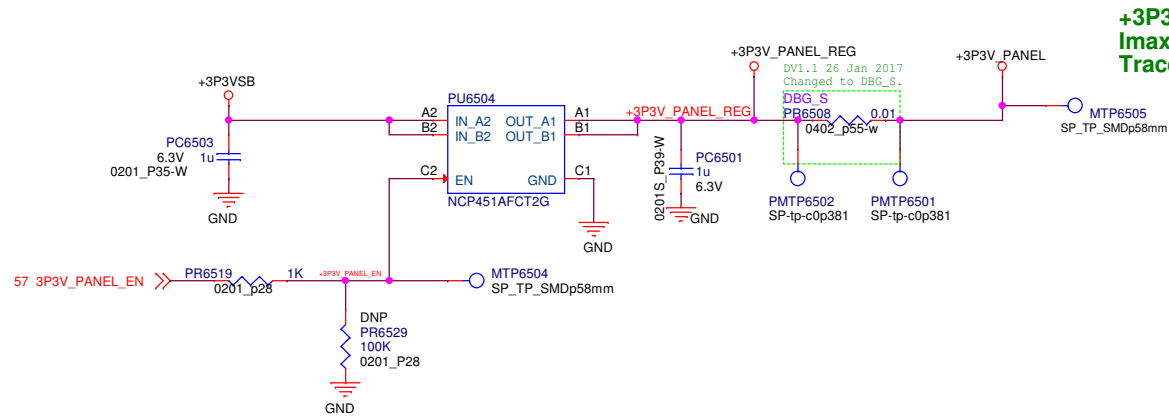


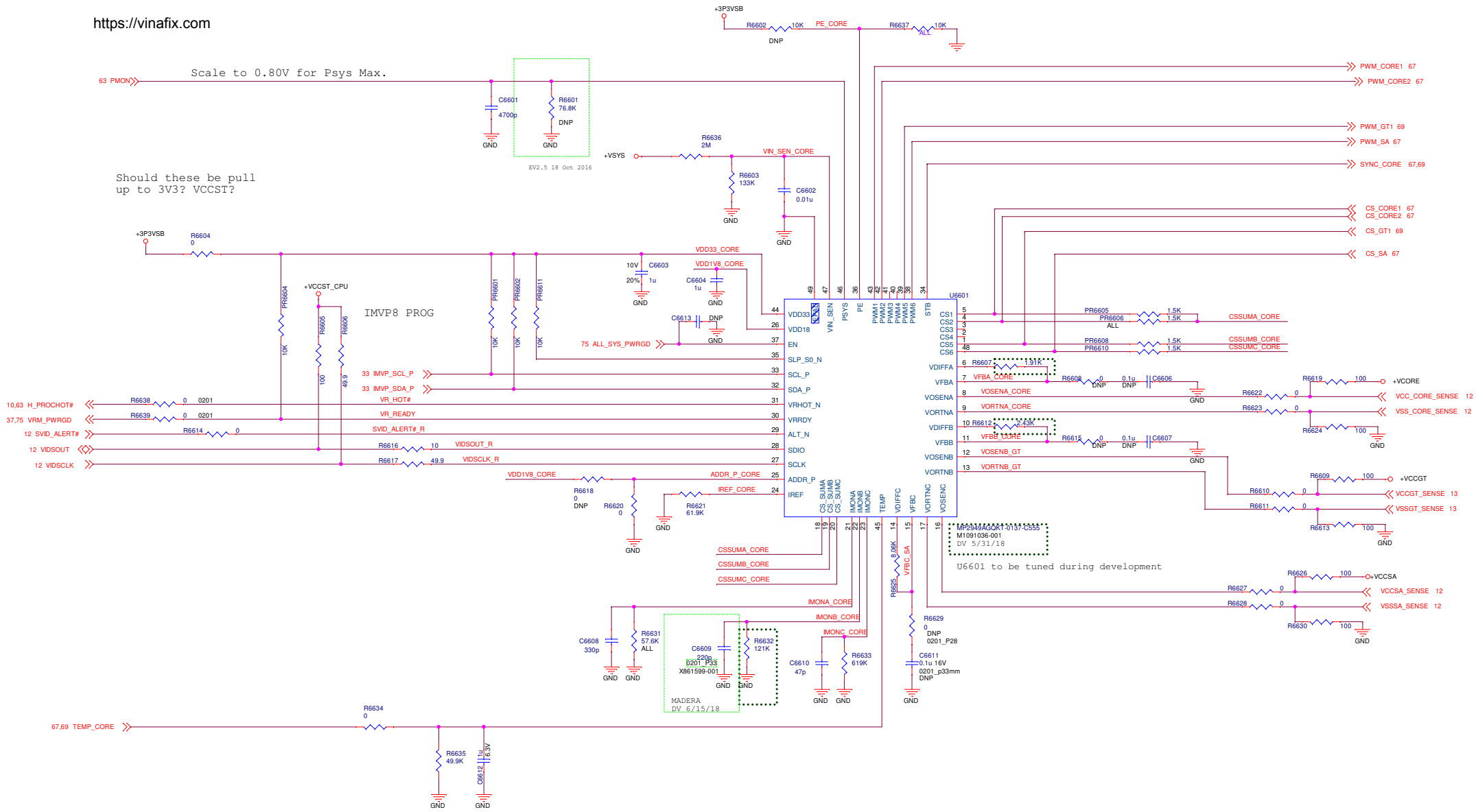


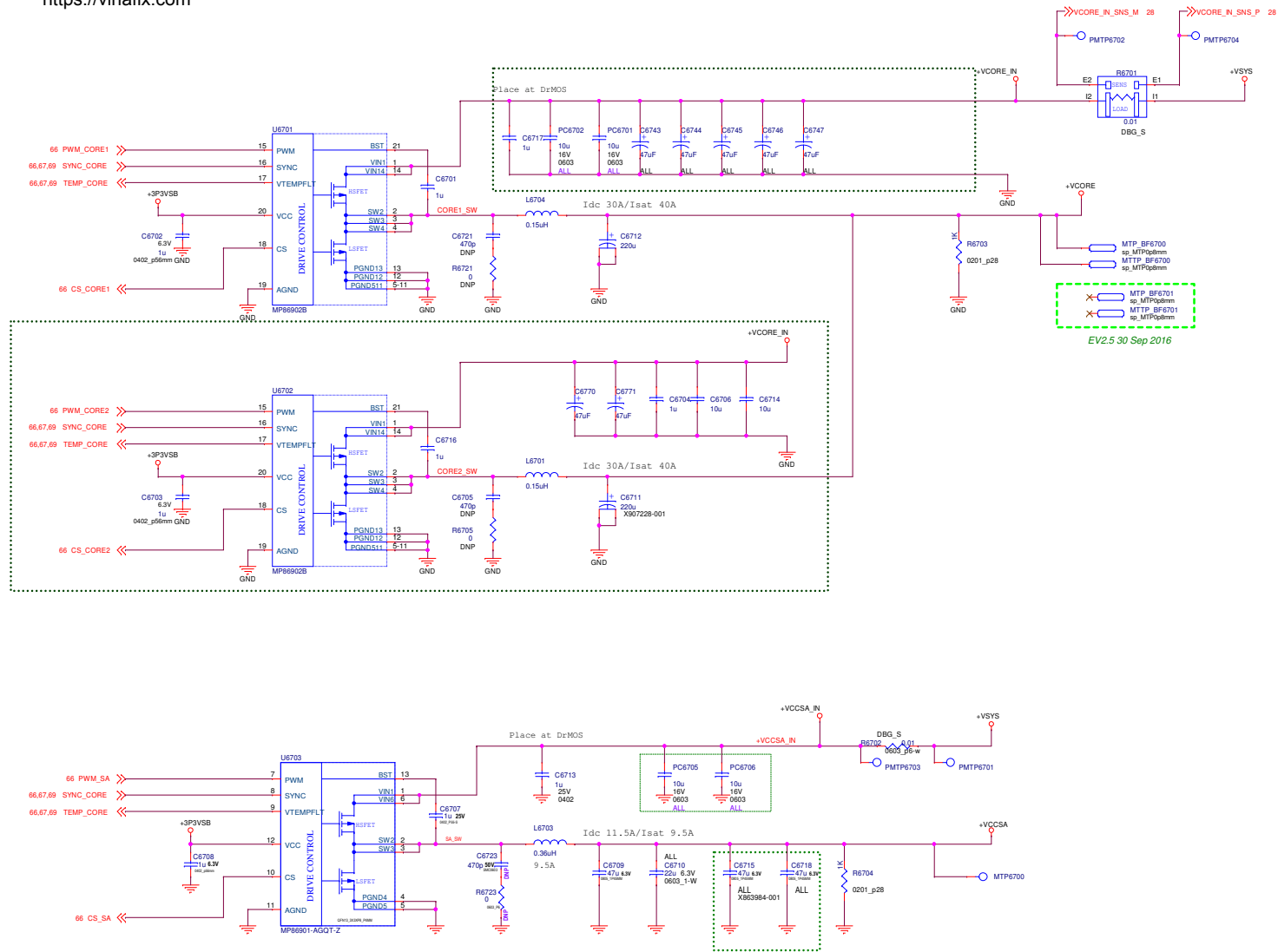




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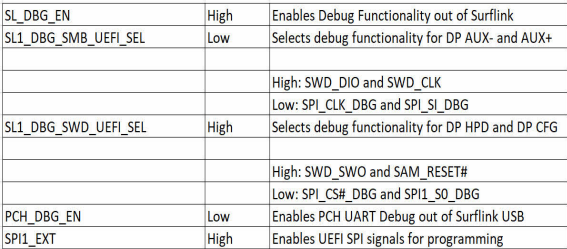


EV2.5 30 Sep 2016

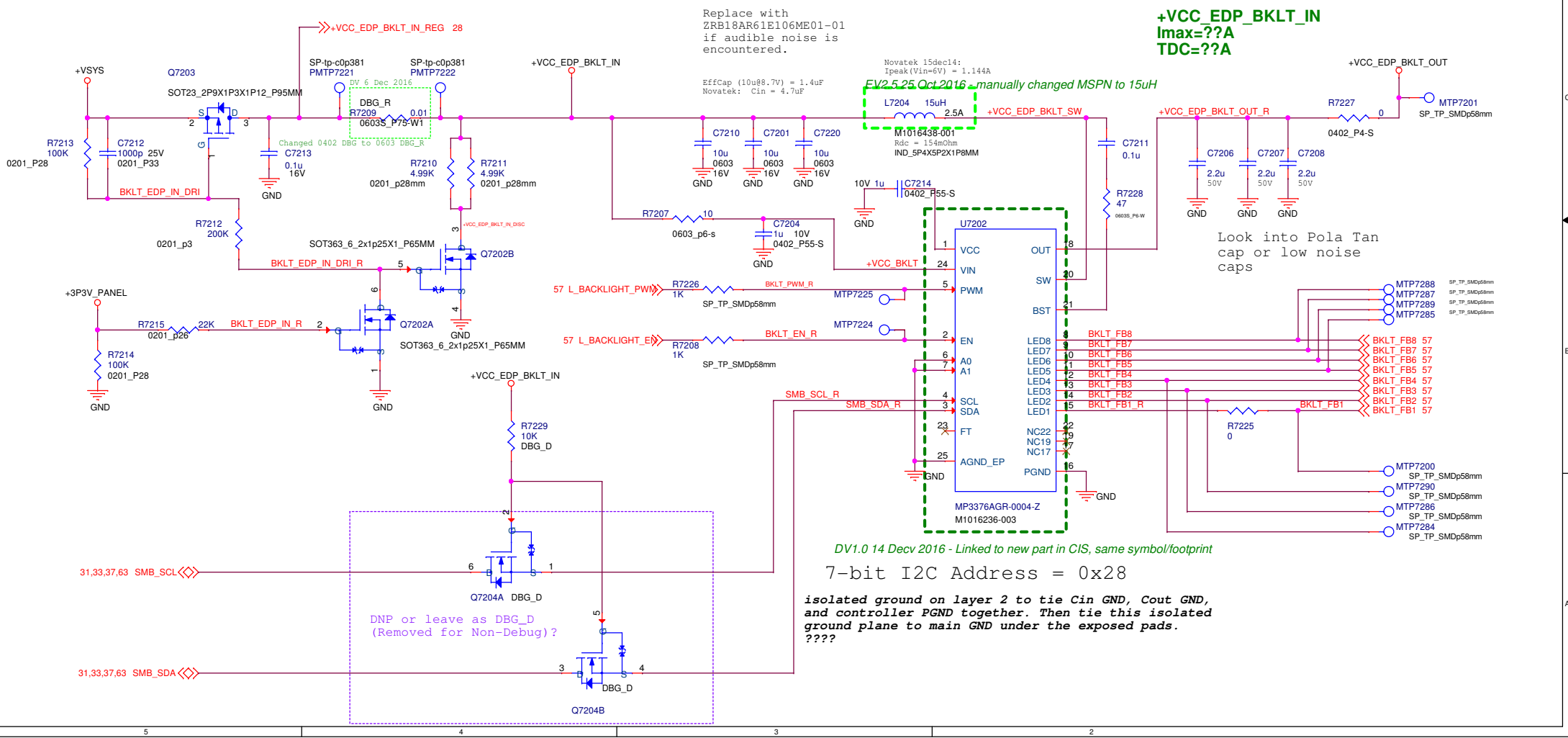
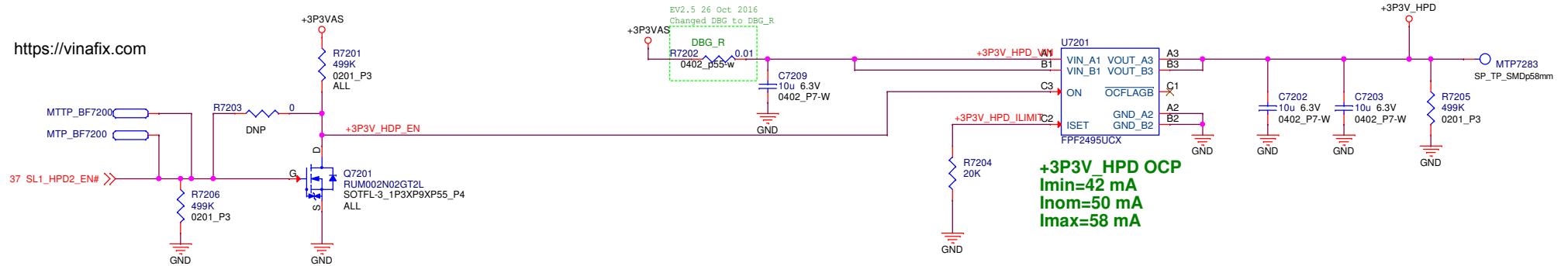








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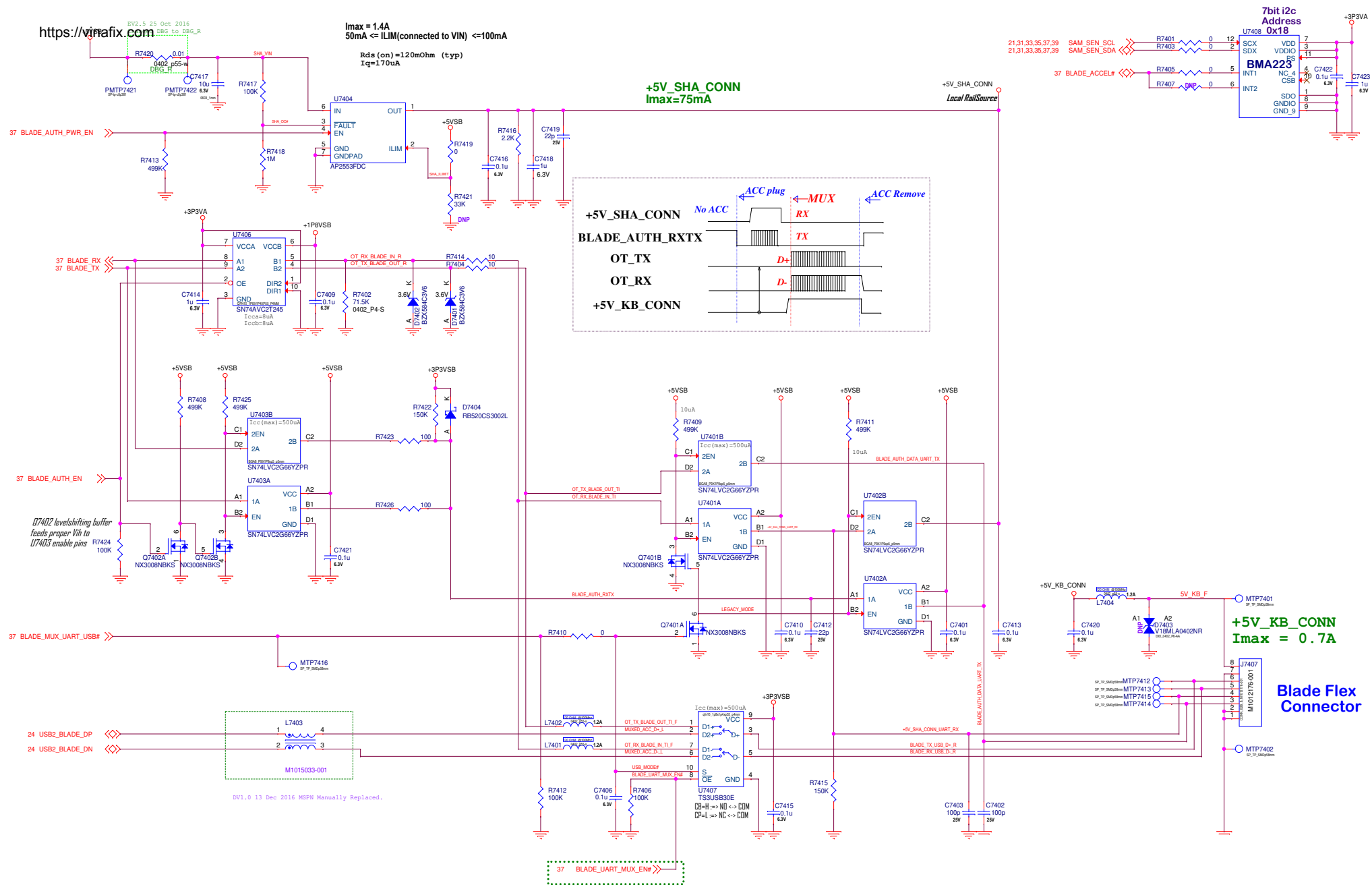


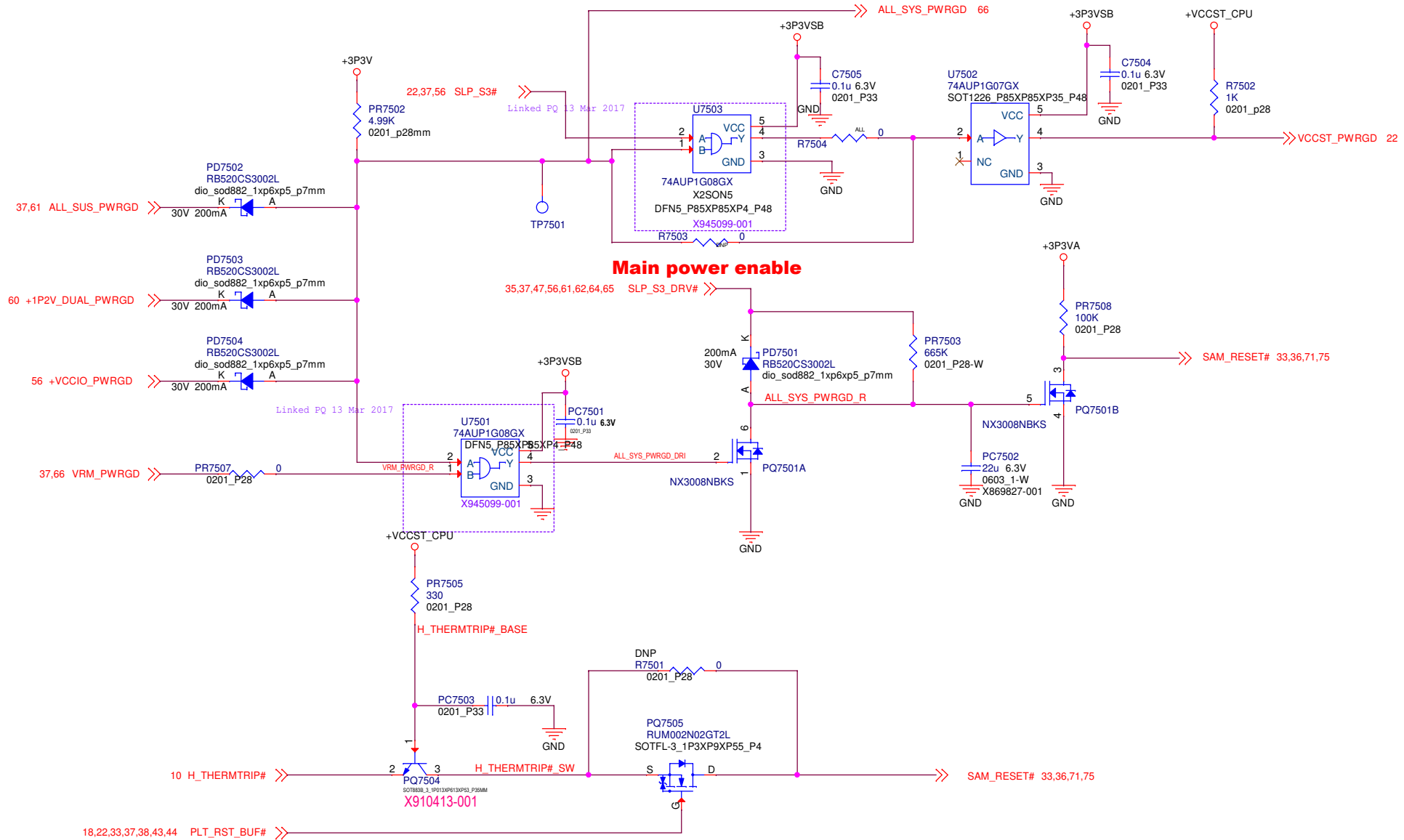


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# *PCIe/USB Debug Expansion Connector*

REMOVED EXPANSION CONNECTOR





Check actual placement of RF Fence pairs  
<https://vinafix.com>

